



FOR MESSRS:

DATE : 03. Aug. 2007

STD

CUSTOMER'S SPECIFICATIONS (APPROVAL)

160cm (63 Inch) Wide Plasma Display Module

MODEL : S63FH-XD01

(NTSC,PAL)

- * This specification will be approved by both [STD](#) and Samsung SDI Co.,Ltd.
- * Please return one of this specification with your signature for approval.

Proposed by:

Approved by:

Signature

Signature

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Revision History

No	Date	Description Of Changes	Rev. no	Approval																				
1	07-04-18	Newly Established.	0.1	Tentative																				
2	07-07-31	Total 10 items are revised as below.	1.0	Approval																				
		1. Contrast ratio is changed as below. (5p, 7p)																						
		<table><tr><th rowspan="2">Condition</th><th colspan="2">Before</th><th colspan="2">After</th></tr><tr><th>Typical</th><th>Minimum</th><th>Typical</th><th>Minimum</th></tr><tr><td>NTSC</td><td>7,000 : 1</td><td>5,500 : 1</td><td>7,000 : 1</td><td>5,000 : 1</td></tr><tr><td>PAL</td><td>3,500 : 1</td><td>2,500 : 1</td><td>4,500 : 1</td><td>3,500 : 1</td></tr></table>				Condition	Before		After		Typical	Minimum	Typical	Minimum	NTSC	7,000 : 1	5,500 : 1	7,000 : 1	5,000 : 1	PAL	3,500 : 1	2,500 : 1	4,500 : 1	3,500 : 1
		Condition	Before		After																			
			Typical	Minimum	Typical	Minimum																		
		NTSC	7,000 : 1	5,500 : 1	7,000 : 1	5,000 : 1																		
		PAL	3,500 : 1	2,500 : 1	4,500 : 1	3,500 : 1																		
		2. Inspection pattern of Cell Defect is changed. (11p)																						
		<table><tr><th>Before</th><th>After</th></tr><tr><td>Black Pattern</td><td>White / R / G / B Pattern</td></tr></table>				Before	After	Black Pattern	White / R / G / B Pattern															
		Before	After																					
		Black Pattern	White / R / G / B Pattern																					
		3. APC Offset level is modified. (13p)																						
		<table><tr><th>Condition</th><th>Before</th><th>After</th></tr><tr><td>2/3 Peak Bright Mode</td><td>60 h</td><td>E7 h</td></tr><tr><td>1/3 Peak Bright Mode</td><td>C7 h</td><td>1FF h</td></tr></table>				Condition	Before	After	2/3 Peak Bright Mode	60 h	E7 h	1/3 Peak Bright Mode	C7 h	1FF h										
		Condition	Before	After																				
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		1/3 Peak Bright Mode	C7 h	1FF h																				
		4. GTSEL(Gamma Table Selection) is removed. (17p)																						
5. Sound Pressure Level is changed. (18p)																								
<table><tr><th>Condition</th><th>Before</th><th>After</th></tr><tr><td>Measuring Condition</td><td>2,000m</td><td>2,300m</td></tr><tr><td>Specification</td><td>40.xxdB</td><td>39.xxdB</td></tr></table>				Condition	Before	After	Measuring Condition	2,000m	2,300m	Specification	40.xxdB	39.xxdB												
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6. Operational Environmental Condition is changed. (20p)																								
<table><tr><th>Item</th><th>Before</th><th>After</th></tr><tr><td>Display Operation</td><td>-5℃ ~ 60℃</td><td>-5℃ ~ 55℃</td></tr><tr><td>Specification</td><td>40.xxdB</td><td>39.xxdB</td></tr></table>				Item	Before	After	Display Operation	-5℃ ~ 60℃	-5℃ ~ 55℃	Specification	40.xxdB	39.xxdB												
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Specification	40.xxdB	39.xxdB																						
7. Storage Environmental Condition is changed. (20p)																								
<table><tr><th rowspan="2">Condition</th><th colspan="2">Before</th><th colspan="2">After</th></tr><tr><th>Recommended</th><th>Absolute Max</th><th>Recommended</th><th>Absolute Max</th></tr><tr><td>Temperature</td><td>-20℃ ~ 70℃</td><td>-20℃ ~ 80℃</td><td>-5℃ ~ 45℃</td><td>-20℃ ~ 70℃</td></tr><tr><td>Pressure</td><td>750 ~ 1013 hPa</td><td>307 ~ 1013 hPa</td><td>850 ~ 1013 hPa</td><td>307 ~ 1013 hPa</td></tr></table>					Condition	Before		After		Recommended	Absolute Max	Recommended	Absolute Max	Temperature	-20℃ ~ 70℃	-20℃ ~ 80℃	-5℃ ~ 45℃	-20℃ ~ 70℃	Pressure	750 ~ 1013 hPa	307 ~ 1013 hPa	850 ~ 1013 hPa	307 ~ 1013 hPa	
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Pressure	750 ~ 1013 hPa	307 ~ 1013 hPa	850 ~ 1013 hPa	307 ~ 1013 hPa																				
8. Ripple & Noise Spec of Electrical Characteristic is added. (39p)																								
9. Pin Assignment of connectors for AC Input is added. (41p)																								
10. Product Label is updated. (48p)																								

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1. DESCRIPTION

The S63FH-XD01 is a 63-inch wide full color plasma display Module with a resolution of 1920(H) × 1080(V) pixels. The display module includes the Plasma Display Panel, the Panel Driving Electronics, the Logic Control Board.

2. FEATURES

- Wide aspect ratio(16:9) in 63 inch diagonal display screen. The display area is 1393.92mm wide and 784.08mm high.
- Slim and light weight. The display module is 70.1mm in depth and weighsonly approx. 41.4kg.
- 68719.47 million colors(12Bit), 1073.7 million colors(10Bit), or 16.77 million colors(8Bit) combination of R,G and B digital data.(according to LVDS input selection)
- High Luminance, High contrast, Wide viewing angle. The screen has a white peak luminance of typical 1,000 cd/m²(NTSC,PAL), contrast of typical 7,000:1(NTSC), 4,500:1(PAL). The viewing angle of 160° or greater is achieved.

3. PRODUCT NAME AND MODEL NUMBER

- Product name : 63 inch Full Color Plasma Display Module1
(abbreviation : PDP Module1)
- Model number : S63FH-**XD01**
- Product Code : PP63FH001A

4. FUNCTION OUTLINE

- The plasma display module has an APC(Automatic Power Control) function which restricts power consumption within a certain range with respect to each display load ratio.
- The plasma display module is operated by input digital video signals; vertical synchronous signal (vsync), horizontal synchronous signal (hsync), data enable signal and 8~12bits data signal for the respective R,G, and B color. All digital video signals are transferred by a LVDS cable.
- The plasma display module is operated at 60Hz/50Hz frame rate.
- The plasma display module requires several levels of input power voltages respectively for the logic main, the TCP's, the gate drivers, the sustain switches, the column drivers, Y-Set, Y-scan, and X-bias.
- The plasma display module is operated at progressive scan video input signal only.
An external progressive scan conversion is required in order to display the other formats.

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5. BLOCK DIAGRAM

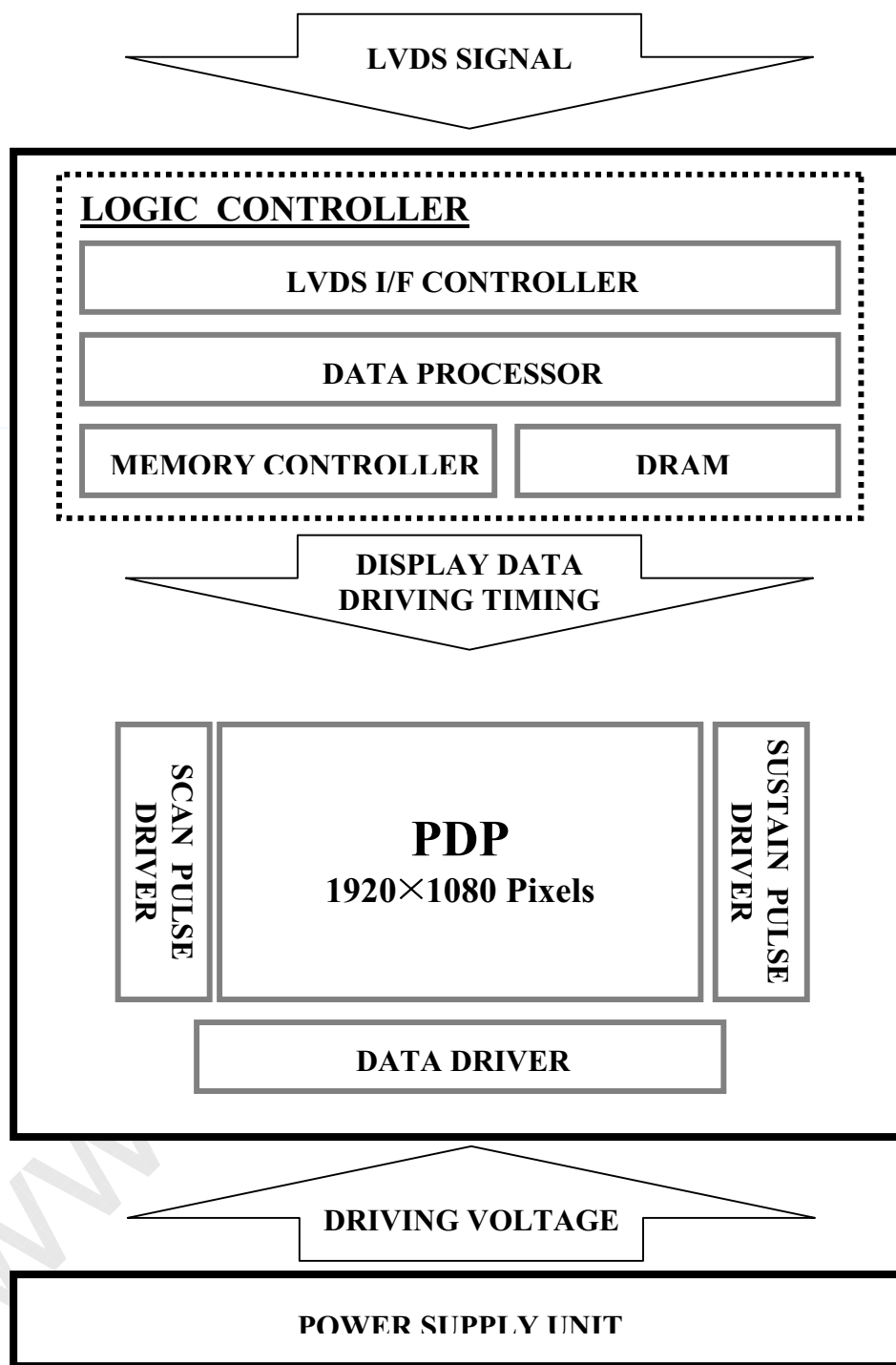


Figure-1. Block Diagram of PDP module



6. DISPLAY CHARACTERISTICS

6.1 Display Performance

No	Item	Rating	
1	Display Pixels	Horizontal 1,920 × Vertical 1,080 pixels (1 pixel = 1 R,G,B cells)	
2	Display Cells	Horizontal 5,760 cells × Vertical 1,080 cells	
3	Pixel Pitch	Horizontal 0.726mm × Vertical 0.726mm	
4	Cell Size	R	Horizontal 0.242mm × Vertical 0.726mm
		G	Horizontal 0.242mm × Vertical 0.726mm
		B	Horizontal 0.242mm × Vertical 0.726mm
5	Pixel Type	R, G, B Non stripe (refer to Figure-2)	
6	Effective Display Size	Horizontal 1393.92mm × Vertical 784.08mm [54.88 inch (H) × 30.87 inch (V)]	
7	Number of color	68719.47 million colors (12Bit) 1073.7 million colors (10Bit) 16.77 million colors (8Bit)	
8	Peak Luminance *1 (peak algorithm on)	NTSC: Typical 1,000 cd/m ² , Minimum 900 cd/m ² PAL: Typical 1,000 cd/m ² , Minimum 900 cd/m ²	
9	Contrast Ratio *2 (in dark room, peak algorithm on)	NTSC: Typical 7,000:1, Minimum 5,000:1 PAL: Typical 4,500:1, Minimum 3,500:1	
10	Brightness (Full white Brightness)	NTSC: Typical 170cd/m ² , Minimum 155 cd/m ² PAL: Typical 170cd/m ² , Minimum 155 cd/m ²	
11	Viewing Angle *3	Over 160°	

(Note)

- * 1. The luminance and color coordinates are measured at a full white pattern (load ratio 100%). The condition for measurement is shown in Figure-3.
- * 2. The contrast ratio is calculated from the display luminance and the non-display luminance value. Display condition is shown in Figure-4.
- * 3. The viewing angle is a critical angle at which the observed luminance is reduced to 30% to the luminance perpendicular to the PDP module. The luminance is measured by a non-contact luminance meter BM-7.

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6.2 Display Cell Arrangement

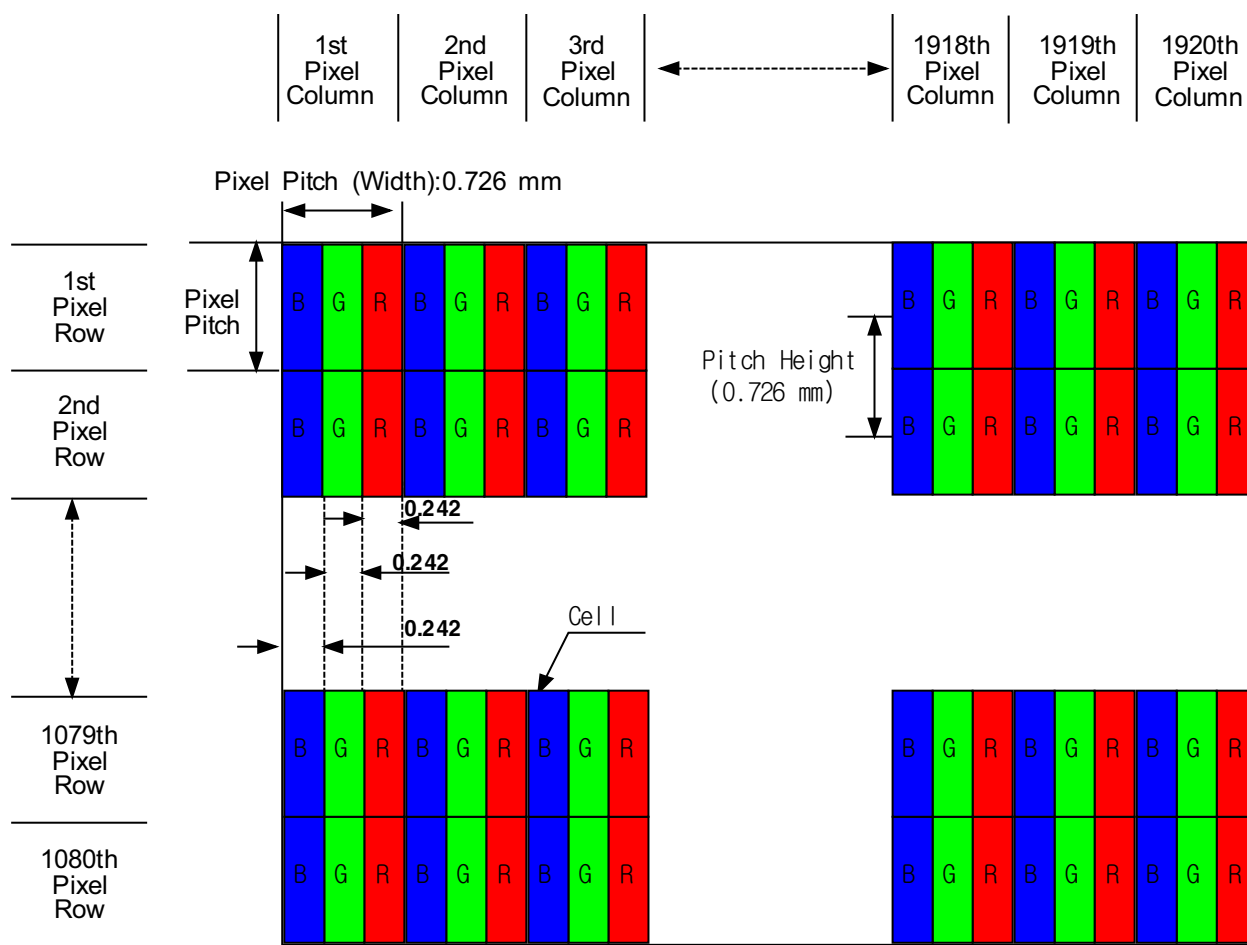


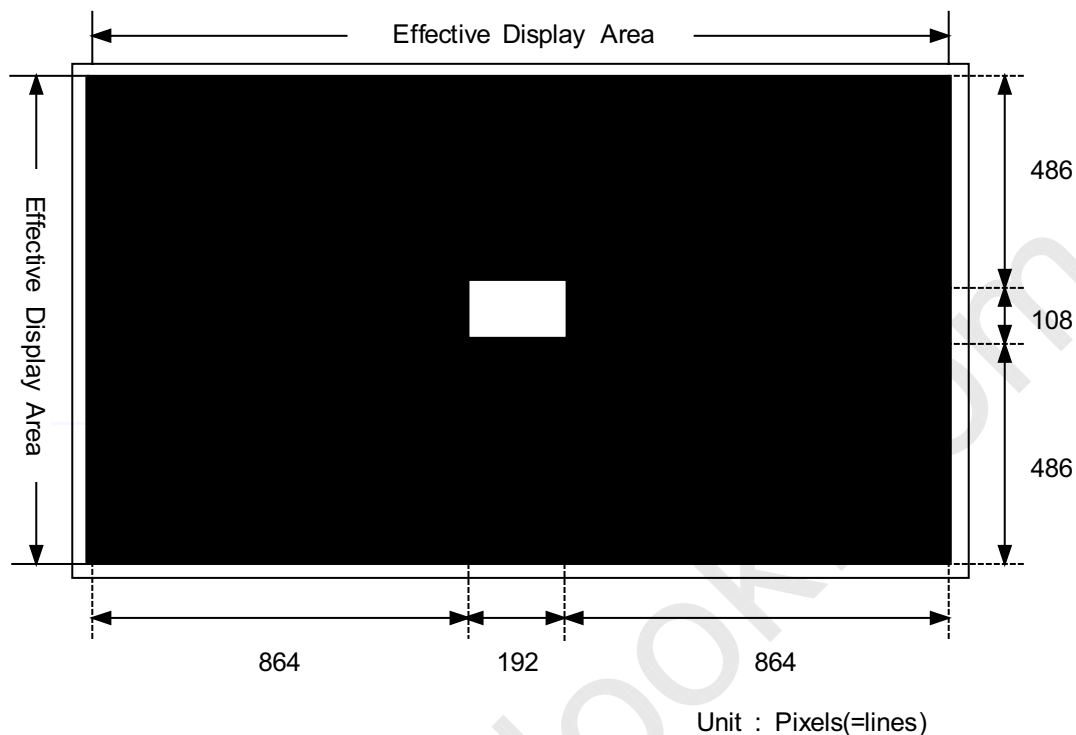
Figure-2.Display Cell Arrangement

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6.3 Luminance Measurement Condition

(1) Display Pattern



- marked area : White display area by maximum gradation setting
- marked area : Black color (non-display area)

Figure-3. Display Pattern for Brightness & Contrast Ratio Measurement

(2) Display area ratio : 1% white window

(3) Vsync : 16.7ms

(4) Measuring equipment : MINOLTA CA-100Plus
Pattern Generator(VG-828, LVDS Output).

(5) Ambient Temperature : Room Temperature

(6) Ambient Luminance : Dark Room (<2 lux)

[Note]

1. Measured within 30 seconds after a power-on. The temperature of the panel before the measurement is a room temperature (25°C).
2. Measured done within 3 seconds after the pattern starts being displayed. (Figure-3)

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6.4 Contrast Measurement Condition

(1) Measuring point

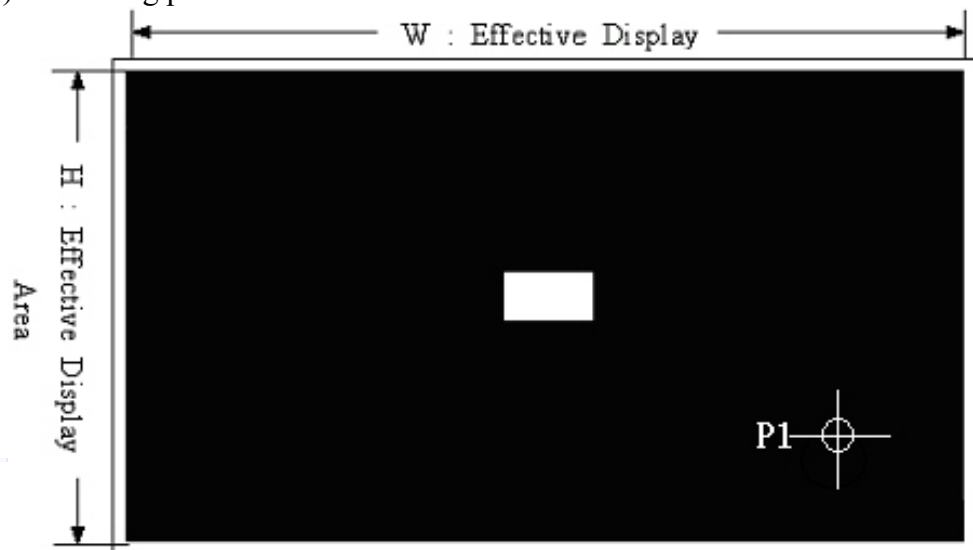


Figure-4. Measurement point

(2) Vsync : 16.7 ms

(3) Measuring Equipment : MINOLTA CA-100Plus
Pattern Generator(VG-828, LVDS Output).

(4) Contrast Calculation formula

$$\text{Contrast ratio} = \frac{\text{Luminance of 1\% white window area at the center of the screen}}{\text{Luminance of black area}}$$

【 Note 】

1. For mass production test purposes, it is recommended to measure only the single point, P1 of Fig. 4 at the display pattern of Fig.3.
2. The measurement point P1 is the minimum luminance point inside the effective display area.

(5) Ambient light condition : dark room (<2 lux)

6.5 Display Cell Defect Specification

In some cases, a panel may have defective cells produced in panel-making processes.

These defective cells can be categorized into three types;

- (1) Non-lighting cell defect : defect in which the cell is always off
- (2) Non-extinguishing cell defect : defect in which the cell is always on.
- (3) Flickering cell defect : defect in which the cell flickers.
- (4) High intensity cell defect : defect in which the cell is brighter than neighboring cells
- (5) Test pattern : Full White, Full Red, Full Green and Full Blue with 1023 gray level.

The display cell defect specifications define the allowed limits for the number of the cell defects and are used as the criteria to determine whether the panel in concern should be delivered to a customer.

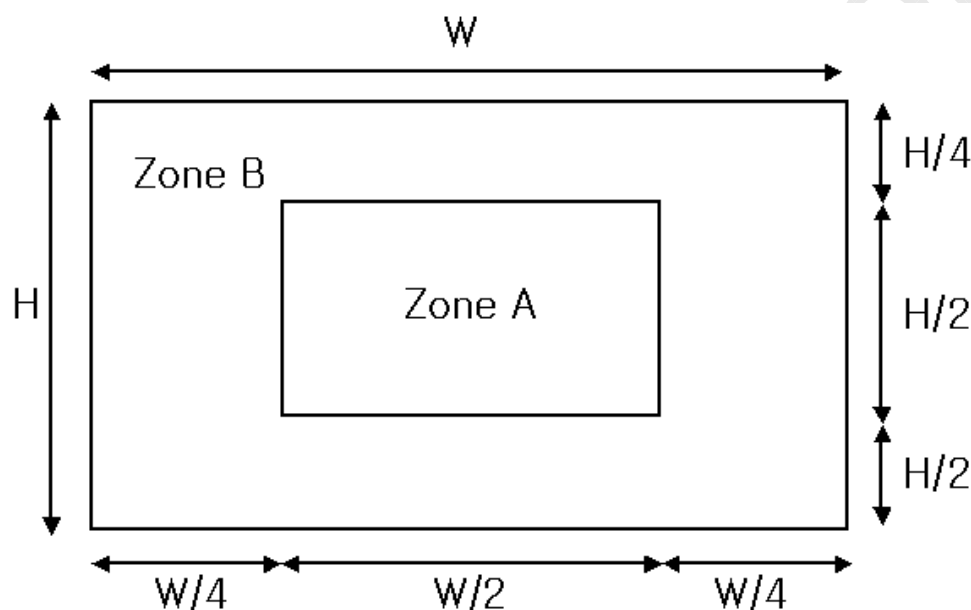


Figure-5. Measurement Area

Item	Number of cell defects		Remark
	A Zone	B Zone	
Non-lighting cell	3 and less	10 and less	Regardless of A and B Zone, Maximum 1 Cell Defect in an area of 50*50mm is allowed.
Non-extinguishing cell	1	2 and less	
Flickering cell (White/Red/Green/Blue pattern)	2	3 and less	
Flickering cell (the other pattern)	1	2 and less	
High Intensity Cell	1	2 and less	
Total defect	13 and less		

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6.6 Uniformity Specifications

The color-PDP uses a ultraviolet light produced by a series of gas discharges to illuminate the phosphor material inside the panel.

Non-uniform phosphor coating and variations of discharge characteristics may result in a slight difference of brightness depending on the positions inside a panel.

Item	Definition	Specification
Full white brightness variation	The brightness is measured at 9 points (A1~A9 of Fig. 6) on full white pattern. The full white brightness variation is then calculated from the following equations where $\bar{x}$ is the measured value .	10% and less
Equation	$\frac{Max - \bar{x}}{\bar{x}} \times 100\% \quad \& \quad \frac{\bar{x} - Min}{\bar{x}} \times 100\%$	

The brightness variation specifications define the allowed limits for brightness differences used as the criteria in determining whether the panel is delivered to a customer.

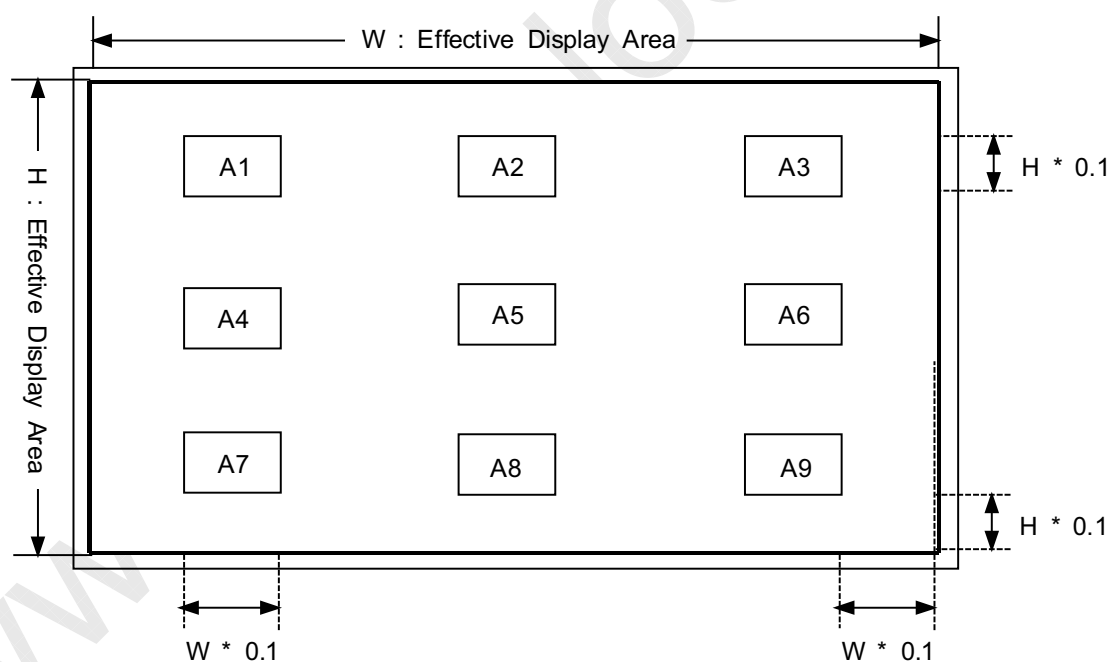


Figure-6. Measuring areas

6.7 Power consumption

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1) APC (Automatic Power Control) Function

The module has an APC (Automatic Power Control) function for the panel driver power source. When the total display load ratio exceeds approximately 10%, total power consumption is limited within a specified level(=Lower Power Limit) by APC function. The operation behaviour of APC function is called as SLOW-APC. When the display load-ratio changes from a low to a high value, the power-consumption rises instantly to “Upper Power Limit” and gradually decreases until it reaches to the “Lower Power Limit”.

[Note] Number of steps may vary as a function of the load ratio.

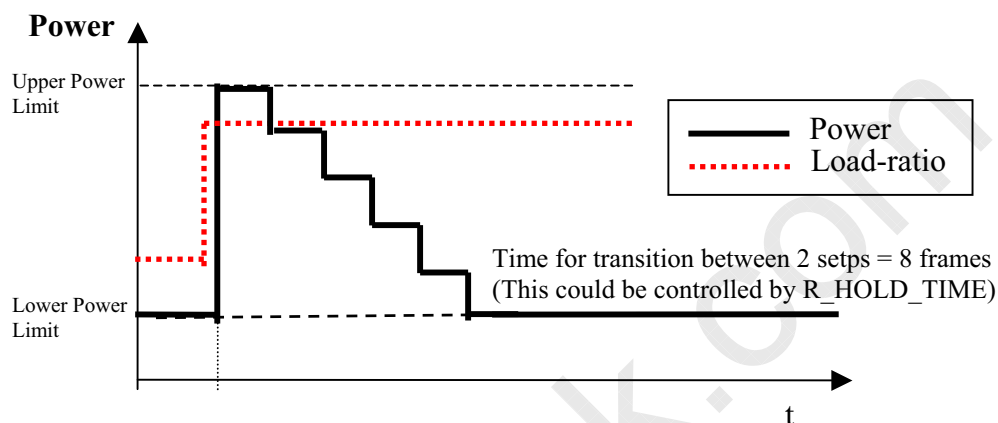


Figure-8 Slow APC Behaviour

2) Brightness and Power Mode Control

This module offers two methods for brightness and power mode control.

One is APCO(APC Offset) for Peak-Brightness control, and the others are PUG and PLG

for power mode control. APCO(89C0h) and PLG(89DAh) are registers controllable through I2C communication from an image B'd. For the detailed explanations of these registers, refer to the Chapter 11. Register Map.

(1) Peak-Brightness Control(APCO)

- controls the max.sustain number
- APCO variable range : 00~C7h

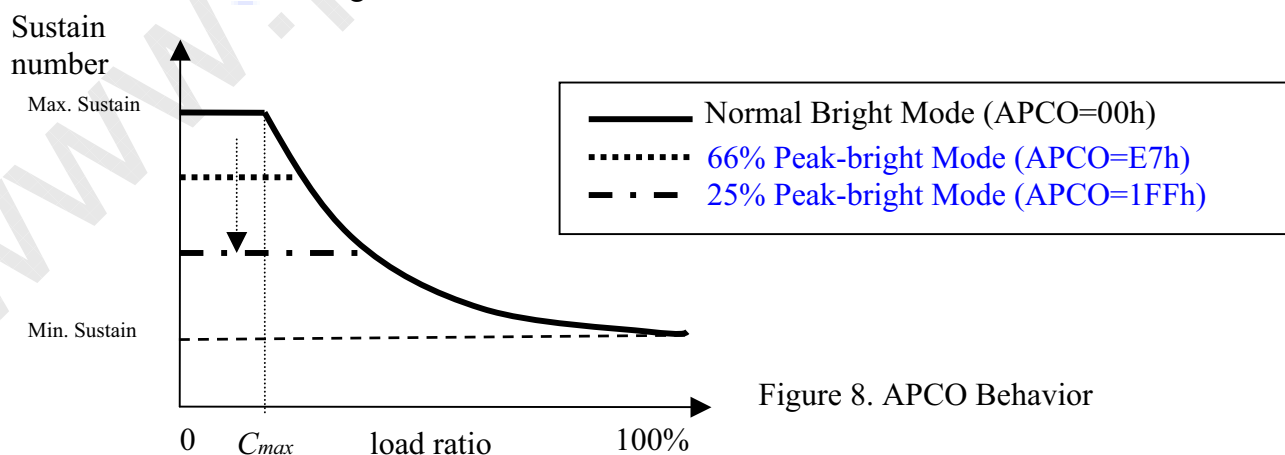


Figure 8. APCO Behavior

(2) ASLG(89C6h) (Power-Mode Control using ASL gain function)

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- ASLG variable range : 80h~FFh
- Maximum available power decrease by increasing ASLG above 80h(NTSC)

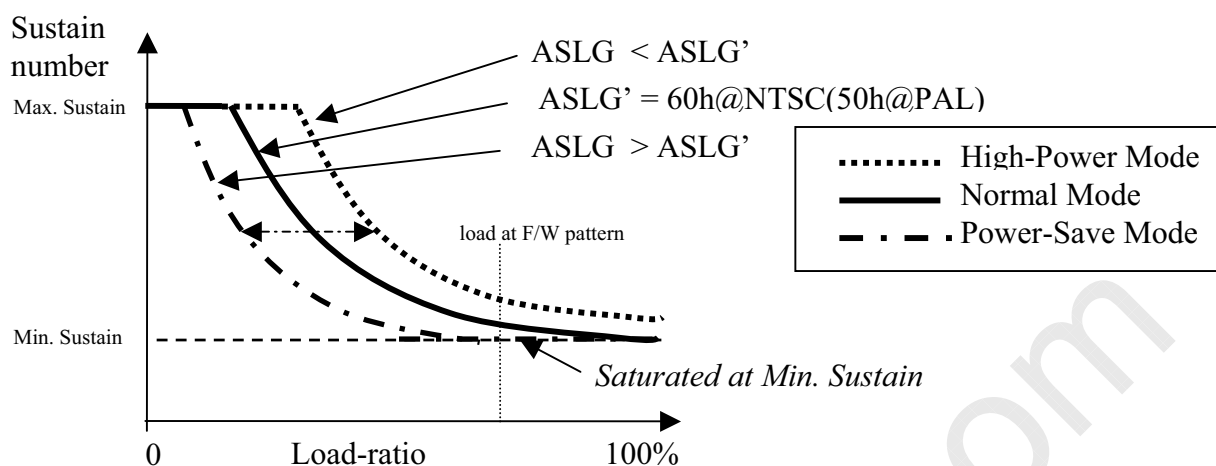


Figure-9. ASLG Behavior

(3) Power-Mode Control via **PLG**

- PLG(Power Lower Gain control register)
- Variable range : 00 ~ 80h(Tentative) , Default Value : 80

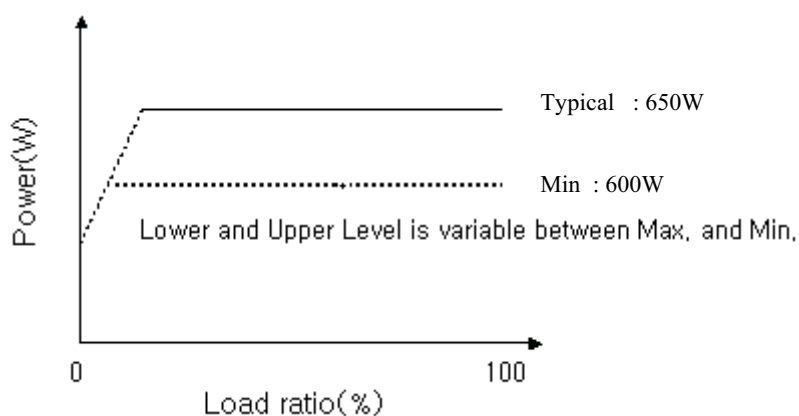


Figure 10. APC Behavior(PLG Adjusted)

(4) Power- Consumption Ratio(**BY ASLG, PLG**)

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PLG	ASLG	ASLG_SW	Power- Consumption Ratio
80	80	OFF	100%
74	80	OFF	90%
6C	8B	OFF	86%
6C	93	ON	80%
6C	A9	ON	70%
6C	DC	ON	60%
6C	FF	ON	55%

【 Note 】 Condition By Moving Picture(30% Window Size)

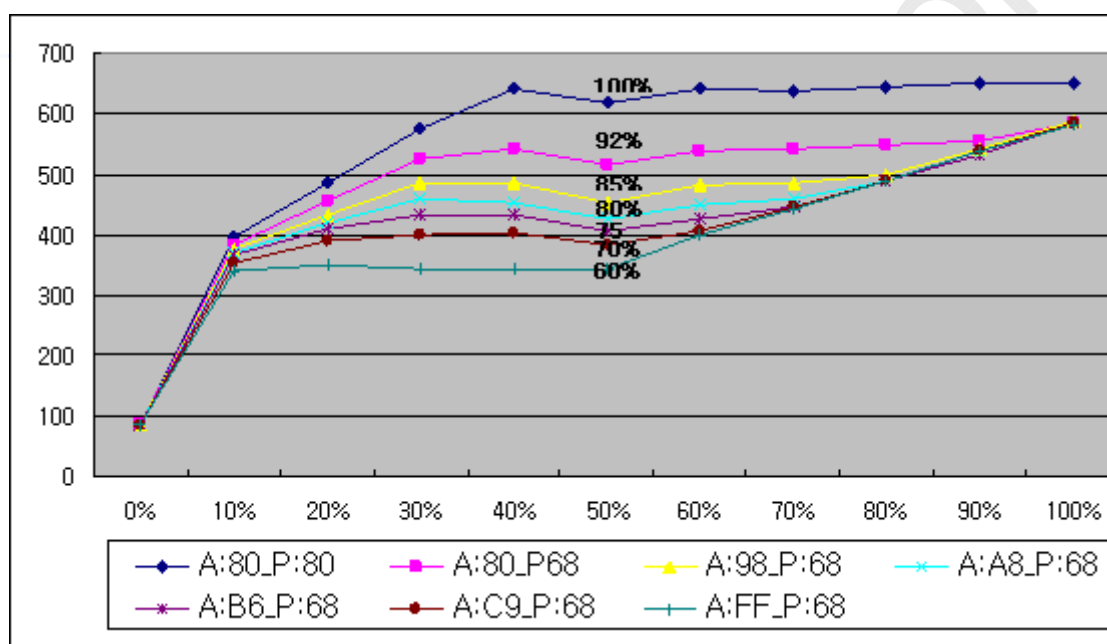


Figure 11. Power- Consumption Ratio by the window size(Load Ratio)

(5) APC_Timer

The module is equipped with the APC Timer function to reduce the amount of image

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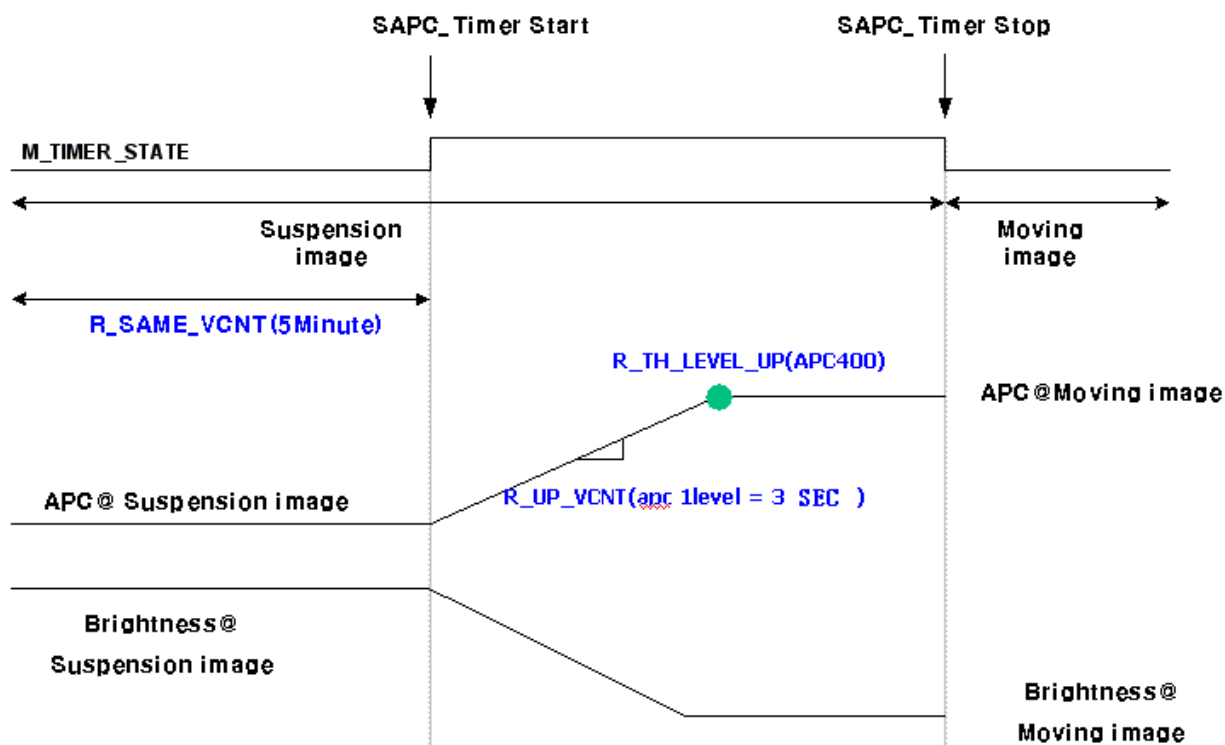
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retention. If the input image is not varying for at least five minutes, the function starts to operate and reduce the initial APC level one step down to a predefined target level in every three seconds. The function is immediately turned off when the input image starts varying.



6.8 Gamma characteristics

The module offers a variety of preset gamma's, as well as a direct control by a customer. The registers regarding gamma selection and control are adjustable through I2C

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communication from an image B'd. For detailed addresses and explanation of the registers, refer to the Chapter 11. Register Map.

1) Basic gamma curve

The module is initially set to a default 2.2 gamma curve (refer to Figure. 12)

However, the initial gamma setting could be adjusted to any values at the request of a the customer.

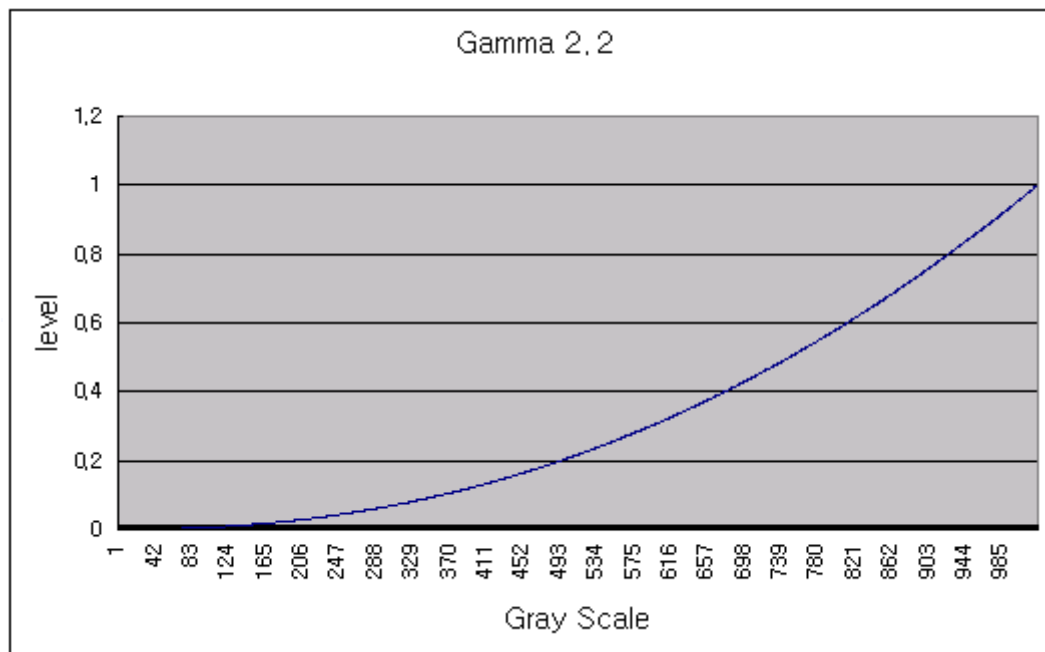


Figure-12. Default Gamma Curve

7. SOUND PRESSURE LEVEL SPECIFICATION

7.1 Measurement Condition

- (1) Background Noise Level : less than 20dB (Anechoic chanber)
- (2) Measuring Pattern : Full White
- (3) Measuring Equipment : Sound level meter Type 2827 made by B&K
- (4) Measuring Distance : 1.0m from the rear side of the module
- (5) Measuring point

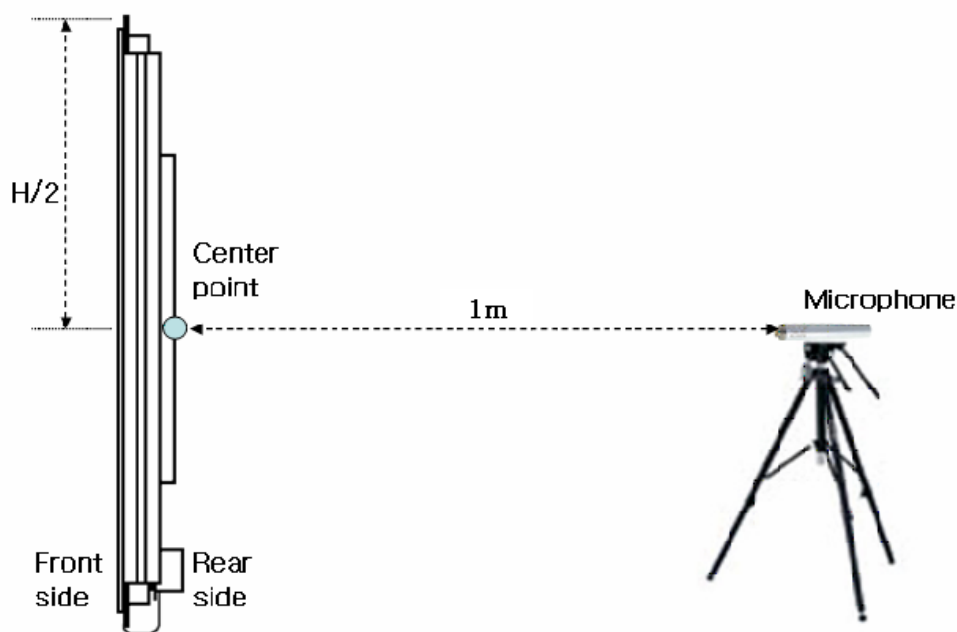


Figure-13. Measuring Point

7.2 Sound Pressure Level

(1) Level Ground (Land)

- Measuring Condition : 0 meter
- Sound Pressure Level is overall level caculated from the individual band levels of 50Hz ~ 8kHz.
- Specification : 30.xx dB (max.)

(2) High Ground

- Measuring Condition : 2,300 meter
- Sound Pressure Level is overall level caculated from the individual band levels of 4 ~ 12.5 KHz.
- Specification : 39.xx dB (max.)

[Note]

1. SDI recommends that the back cabinet of a TV has the ventilation holes of less than 2.7 mm in diameter.
2. Audible noise is guaranteed till the altitude of 2,300 meter.
3. In order to guarantee audible noise at higher altitude than 2,300 meter, a special module has to be used.



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8. MECHANICAL CHARACTERISTICS

8.1 Mechanical Specifications

No	Item	Rating
1	Outer Dimension	Width 1484 mm × Height 875 mm × Thickness 70.1 mm (including FPC and TCP) *see appendix : Mechanical Dimension Drawing
2	Weight	Approximatly 41.4 kg

8.2 Mechanical Characteristics

No	Item	Rating
1	Vibration	Frequency : 10 ~ 55 Hz Sweep Rate : 1 Octave/min Stroke : x,y direction : 0.35 mm Z direction : 0.175 mm
2	Shock	Acceleration : less than 20 G (x,y direction) less than 10 G (z direction) Duration Time : 11 ms

* Notes: (Test condition) Non-Packaging, Operational (only for Vibration)

* Test time of Vibration Test is 30 minutes for every direction(x,y,z)

* The number of times for the shock test is 6 times for every direction(x,y,z).



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9. ENVIRONMENTAL CONDITIONS

9.1 Operational Environmental Condition

No	Item	Rating	
1	Ambient temperature	Display Operation	-5℃ ~ 55℃
		Temperature Slope	Below 1.5 °C/minute
2	Panel Surface Temperature *3	Small Size Pattern	~ 120 °C
		Full White Pattern	~ 85 °C
		Temperature Slope	Below 20 °C/cm
3	Humidity	Display Operation	20 ~ 80 RH (no condensation)
4	Pressure	Display Operation	0 ~ 2,300 m

[NOTE]

1. Functional operation refers to only the electrical function of the module.
2. Display operation refers to both the display and the electrical functions of the module.
3. Panel surface temperature is measured at a normal display mode in a room temperature (25℃). Due to the discharge heat dissipation inside the panel, the temperature appears to become higher for small size pattern (large sustain pulses)
The judgement of display defects (e.g. weak discharge, discharge error) must be performed at an ambient temperature defined in this table.
4. Audible noise is guaranteed up to 2,300m.

9.2 Storage Environmental Condition (*1)

No	Item	Rating	
		Recommended	Absolute maximum
1	Temperature	-5℃ ~ 45℃	-20℃ ~ 70℃
2	Humidity	20 ~ 80% RH	5 ~ 85% RH
3	Pressure	850 ~ 1013 hPa	307 ~ 1013 hPa

[NOTE]

- *1. By the term Storage, we refer to a period of relatively short time for shipping and handling.
(e.g. transportation, relocation and etc.)

9.3 Panel Surface Condition

1) Specification for the surface temperature of panel

The panel surface temperature should be kept as below in order to guarantee a stable display function of input images.

- T_p = below 120°C (Absolute Maximum Rating); when small size of image is displayed
- T_p = below 85°C ; when Full White is displayed.

If the temperature exceeds above level, it may cause the defects of displayed images such as dot defect, line defect, and/or poor image quality.

As the surface temperature of panel tends to rise with deduction of display rate, the relation with temperature can be described as below:

85°C (display load rate is high : large area)

$\sim 120^{\circ}\text{C}$ (display load rate is low : small area)

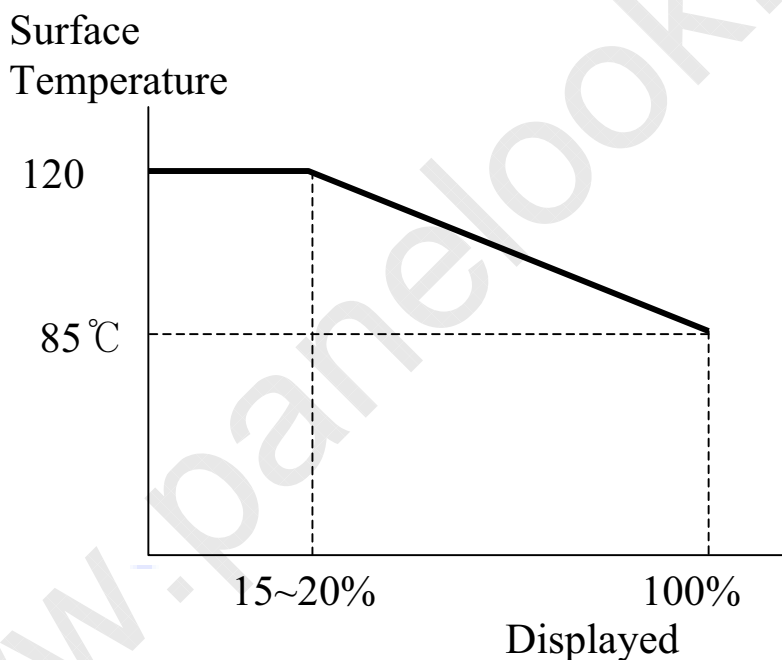


Figure-14. Surface Temperature Vs Displayed Area

It is strongly recommended that the panel surface temperature should be kept as low as possible, even though its maximum rating is described as above.

2) Panel Surface Temperature for Breaking

The temperature uniformity across a panel should be maintained below minimum of $20^{\circ}\text{C}/\text{cm}$ in order not to prevent panel from being broken. However, the threshold $20^{\circ}\text{C}/\text{cm}$ of the temperature gradient inducing cracks could not be precisely specified since the panel cracking also depends critically on own initial conditions such as scratches. Please take the threshold value as a reference.

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10. INTERFACE SIGNAL SPECIFICATIONS

10.1 Interface Configuration

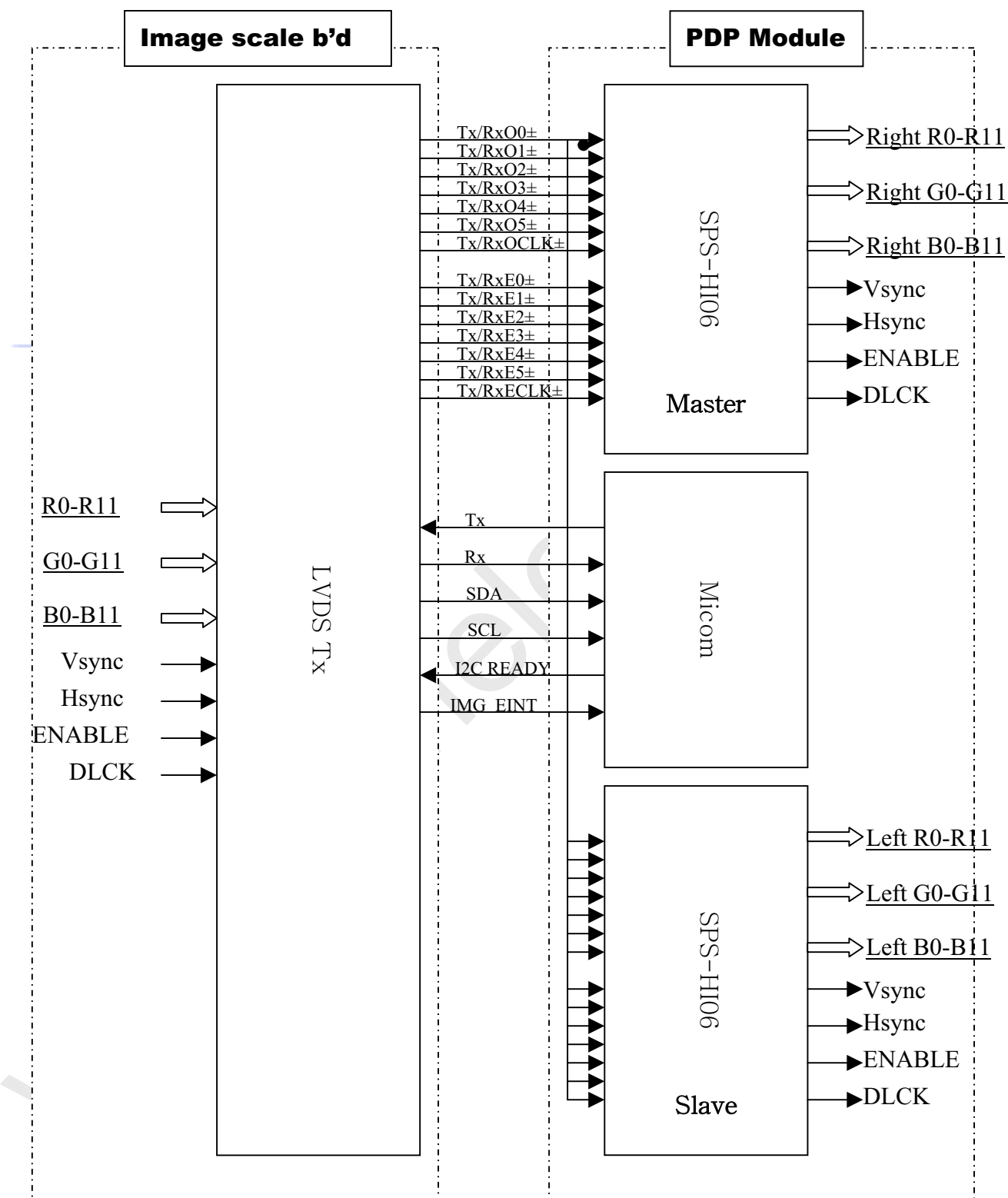


Figure-15. Interface Block Diagram



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10.2 Interface Function Specifications (input data and display processing)

- 1920x1080-dot data and timing signals (video signal) should be provided to the module in order to display images.
- The video signal receiving block is implemented by a data transfer scheme called Low Voltage Differential Signaling (LVDS) interface.
- An I2C bus serial data interface is used for the communication between MPU (Micro-Processor Unit) of a flat TV side and the CLU (Control Logic Unit) of the module.
- I2C_READY signal is used for the CLU to inform the image scaler b'd that CLU is ready for I2C communication.(1 : ready, 0 : not ready)

10.3 Input Signal Definition

No	Item	Signal name		Q	I/O	Method	Definition
1	Display Signal	Video Signal	RxO0±	2	Input	LVDS Differentials	Differential serial data signal. The input parallel video signals in the image scaler b'd is processed to a serial format by using a dedicated differential transmitter. The video signals are then transmitted at a clock rate of the dot clock times seven.
			RxO1±	2			
			RxO2±	2			
			RxO3±	2			
			RxO4±	2			
			RxO5±	2			
			RxE0±	2			
			RxE1±	2			
			RxE2±	2			
			RxE3±	2			
			RxE4±	2			
			RxE5±	2			
				2			
		Dot Clock	RxOCLKin±	2	Input	LVDS Differential	Differential clock signal. The clock signal is transmitted at the same speed as the dot clock.
			RxECLKin±	2			
2	MPU Communication	Comm uni-cation	SDA	1	Input	LVTTL(I2C)	I2C bus serial data/Uart bus serial data communication signal. Communication with the CLU of the module is enabled. *IMG_EINT : PDP Power Down
			SCL	1	Input	LVTTL(I2C)	
			I2C_READY	1	Output	LVTTL(I2C)	
			UART_Rx	1	Input	UART	
			UART_Tx	1	Output	UART	
			IMG_EINT	1	Input	LVTTL	

10.4 LVDS Signal Definition and Function

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A video signal (display data signal and control signal) is converted from parallel data to serial data with the LVDS transmitter and further converted into six sets of differential signals before inputted to the module. These signals are transmitted seven times faster than the dot clock signals. The dot clock signal is separately converted into a differential channel. The LVDS signal definitions and functions are described as follows (in *Italic*):
(LVDS default setting is 12Bit input)

10.4.1 12BIT Application

Signal definition and Pin assignments of the LVDS receiver in CLS

Signal	I/O	Function	Remarks
Rx xxx IN0-	I	Display Data Signal:	LVDS signal (xxx is either odd or even.)
Rx xxx IN0+	I	R4, R5, R6, R7, R8, R9, G4	
Rx xxx IN1-	I	Display Data Signal:	
Rx xxx IN1+	I	G5, G6, G7, G8, G9, B4, B5	
Rx xxx IN2-	I	Display Data Signal:	
Rx xxx IN2+	I	B6, B7, B8, B9, Hsync, Vsync, DEN	
Rx xxx IN3-	I	Display Data Signal:	
Rx xxx IN3+	I	R10, R11, G10, G11, B10, B11,reserved	
Rx xxx IN4-	I	Display Data Signal:	
Rx xxx IN4+	I	R2, R3, G2, G3, B2, B3,N/C	
Rx xxx IN5-	I	Display Data Signal:	
Rx xxx IN5+	I	R0, R1, G0, G1, B0, B1,N/C	
Rx xxx CLKIn-	I	Dot Clock Signal:	
Rx xxx CLKIn+	I	CLK	

Table 1 –Input signal definition and pin assignments of LVDS Receiver (12Bit)

10.4.2 10BIT Application

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Signal	I/O	Function	Remarks
Rx xxx IN0-	I	Display Data Signal:	LVDS signal (xxx is either odd or even.)
Rx xxx IN0+	I	R2, R3, R4, R5, R6, R7, G2	
Rx xxx IN1-	I	Display Data Signal:	
Rx xxx IN1+	I	G3, G4, G5, G6, G7, B2, B3	
Rx xxx IN2-	I	Display Data Signal:	
Rx xxx IN2+	I	B4, B5, B6, B7, Hsync, Vsync, DEN	
Rx xxx IN3-	I	Display Data Signal:	
Rx xxx IN3+	I	R8, R9, G8, G9, B8, B9,reserved	
Rx xxx IN4-	I	Display Data Signal:	
Rx xxx IN4+	I	R0, R1, G0, G1, B0, B1,N/C	
Rx xxx CLKIn-	I	Dot Clock Signal:	
Rx xxx CLKIn+	I	CLK	

Table 2 –Input signal definition and pin assignments of LVDS Receiver (10Bit)

10.4.3 8BIT Application

Signal	I/O	Function	Remarks
Rx xxx IN0-	I	Display Data Signal:	LVDS signal (xxx is either odd or even.)
Rx xxx IN0+	I	R0, R1, R2, R3, R4, R5, G0	
Rx xxx IN1-	I	Display Data Signal:	
Rx xxx IN1+	I	G1, G2, G3, G4, G5, B0, B1	
Rx xxx IN2-	I	Display Data Signal:	
Rx xxx IN2+	I	B2, B3, B4, B5, Hsync, Vsync, DEN	
Rx xxx IN3-	I	Display Data Signal:	
Rx xxx IN3+	I	R6, R7, G6, G7, B6, B7,reserved	
Rx xxx CLKIn-	I	Dot Clock Signal:	
Rx xxx CLKIn+	I	CLK	

Table 3 –Input signal definition and pin assignments of LVDS Receiver (8Bit)



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10.5 LVDS Signal Pin Assignment

The table below indicates pin assignment of the LVDS IC(Receiver in the CLU).

In the 12bit input mode, for other input bit mode, refer to technical references

PIN No	PIN NAME	PIN No	PIN NAME	PIN No	PIN NAME
1	I2C_READY	15	RxOCLKin-	29	RxECLKin-
2	N.C.	16	RxOCLKin+	30	RxECLKin+
3	N.C.	17	RxOIN3-	31	RxEIN3-
4	N.C.	18	RxOIN3+	32	RxEIN3+
5	GND	19	RxOIN4-	33	RxEIN4-
6	GND	20	RxOIN4+	34	RxEIN4+
7	GND	21	RxOIN5-	35	RxEIN5-
8	GND	22	RxOIN5+	36	RxEIN5+
9	RxOIN0-	23	RxEIN0-	37	SCL
10	RxOIN0+	24	RxEIN0+	38	SDA
11	RxOIN1-	25	RxEIN1-	39	IMG_EINT
12	RxOIN1+	26	RxEIN1+	40	UART_Rx(*1)
13	RxOIN2-	27	RxEIN2-	41	UART_Tx(*1)
14	RxOIN2+	28	RxEIN2+		

[Pin assignment Of Receiver]

[NOTE]

*1. Pin40 and pin41 are designated with respect to the module.i.e. through pin40 the module receives UART communication.



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10.6 Video Signal Definition and Function

The table below describes the definitions and the functions of input video signals before LVDS conversion.

Interfaces Signal Functions		
Symbol	Function	Remarks
<u>R11(7) to R0</u>	<u>12(8) bits red video signal (note 1)</u>	Display data signal: <u>R11(7): MSB*</u> , <u>R0: LSB**</u>
<u>G11(7) to G0</u>	<u>12(8) bits green video signal (note 1)</u>	Display data signal: <u>G11(7): MSB*</u> , <u>G0: LSB**</u>
<u>B11(7) to B0</u>	<u>12(8) bits blue video signal (note 1)</u>	Display data signal: <u>B11(7): MSB*</u> , <u>B0: LSB**</u>
<u>Hsync</u>	Horizontal synchronous signal	This signal specifies the data period for one horizontal line. Control of the next line begins at the rising edge of Hsync.
Vsync	Vertical synchronous signal	Timing signal that controls the start of the screen. Control of the next screen begins at the rising edge of Vsync.
DCLK	Clock for video signal	Latch the video signal at falling edge of the clock.

* MSB: Most Significant Bit

**LSB: Least Significant Bit

Note 1: The RGB data signals can be adjusted by inverse γ correction [with the help of halftoning algorithm such as error diffusion or dither] before the transfer to the module. In order to obtain a good characteristic of low level's gray scale, pre-processing of the data via halftoning is advised to be performed prior to being transferred to the module.



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10.7 Electrical Condition of Interface Signal

1) Maximum Ratings

Common conditions : Ta = 25℃, Vcc = 3.3V

Absolute Ratings						
Item			Parameter	Symbol	Ratings	Module
Input Signals	LVDS	Rx0-/+, Rx1-/+, Rx2-/+, Rx3-/+, Rx4-/+, Rx5-/+, CLKIN-/+	Input Voltage	<u>Vi</u>	<u>-0.3~3.6</u>	<u>V</u>
			Input Current	<u>Ii</u>	<u>-15~15</u>	<u>μA</u>
	3.3V CMOS	SDA, SCL	Input Voltage	Vi	<u>-0.5~3.6</u>	V
			Input Current	<u>Ii</u>	<u>-15</u>	<u>mA</u>

2) Electrical Characteristics

Electrical Characteristics							
Signal	Item	Symbol	Conditions	Min.	Typ.	Max.	Module
LVDS	Differential Input High Threshold	V _{th}	V _{CM} =+1.2V	-	-	+100	mV
	Differential Input Low Threshold	V _{tl}	V _{CM} =+1.2V	-100	-	-	mV
	Input Current	I _{in}	V _{IN} = +2.4V V _{cc} = 3.6V	-	-	±10.0	μA
I2C	Input Voltage	V _{ih}		2.0	-	5.0	V
		V _{il}		GND	-	0.8	V
	Input Current	I _{in}	V _{IN} = 0.4V, 2.5V or V _{cc}	-	+1.8	+15	μA
	Output Voltage	V _{oh}	I _{oh} = -0.4 mA	2.7	2.9	-	V
		V _{ol}	I _{oh} = -2 mA	2.7	2.85		V



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10.8 Video Signal Interface Timing Formats

The table below indicates the timing formats to be observed for the input video signal before LVDS conversion. Refer to the figure of the timing chart that follows.

8 bits, 10bit, and 12 bit LVDS mode adopt the same timing formats in common.

Video Input Signal Timing (NTSC/PAL)			
Symbol	Timing	Unit	Remarks
T _{VSYN}	Refer to 'Remark'	Hz	- PAL Long Mode : Below 48Hz - PAL Normal Mode : 48~52Hz - PAL LB Mode : 52~55Hz - NTSC Long Mode : 55 ~ 58 Hz - NTSC Normal Mode : 58 ~ 62 Hz - NTSC LB Mode : 62 ~ 65 Hz - NTSC Mask Mode : above 65 Hz * LB Mode(=Low Brightness Mode) : By decreasing sustain period on the Tvsync shorter than normal, brightness is reduced. * Mask(or Flicker) Mode : Masks abnormally short Vsync, and displays at the frame period twice as input Vsync period. * Long Mode : mode change is not occurred in this period, the display is normally operation by increasing the Vsync period.
T _{VHS (1frame)}	1125	Hsync	No. of Hsync in 1 Vsync Period
T _{WV}	22(Min.)	Tclk	Vsync on time
T _{VH}	36(Min.)	Hsync	Vsync back porch
T _{HSYN}	1100	Tclk	Hsync width
T _{WH}	5(Min.)	Tclk	Hsync on time
T _{HC}	96	Tclk	Hsync back porch
T _{CLK}	72.25 ~ 76.25	MHz	Dot clock(DCLK) frequency
T _{SUD}	5	ns	Minimum Data setup time
T _{HD}	5	ns	Minimum Data hold time

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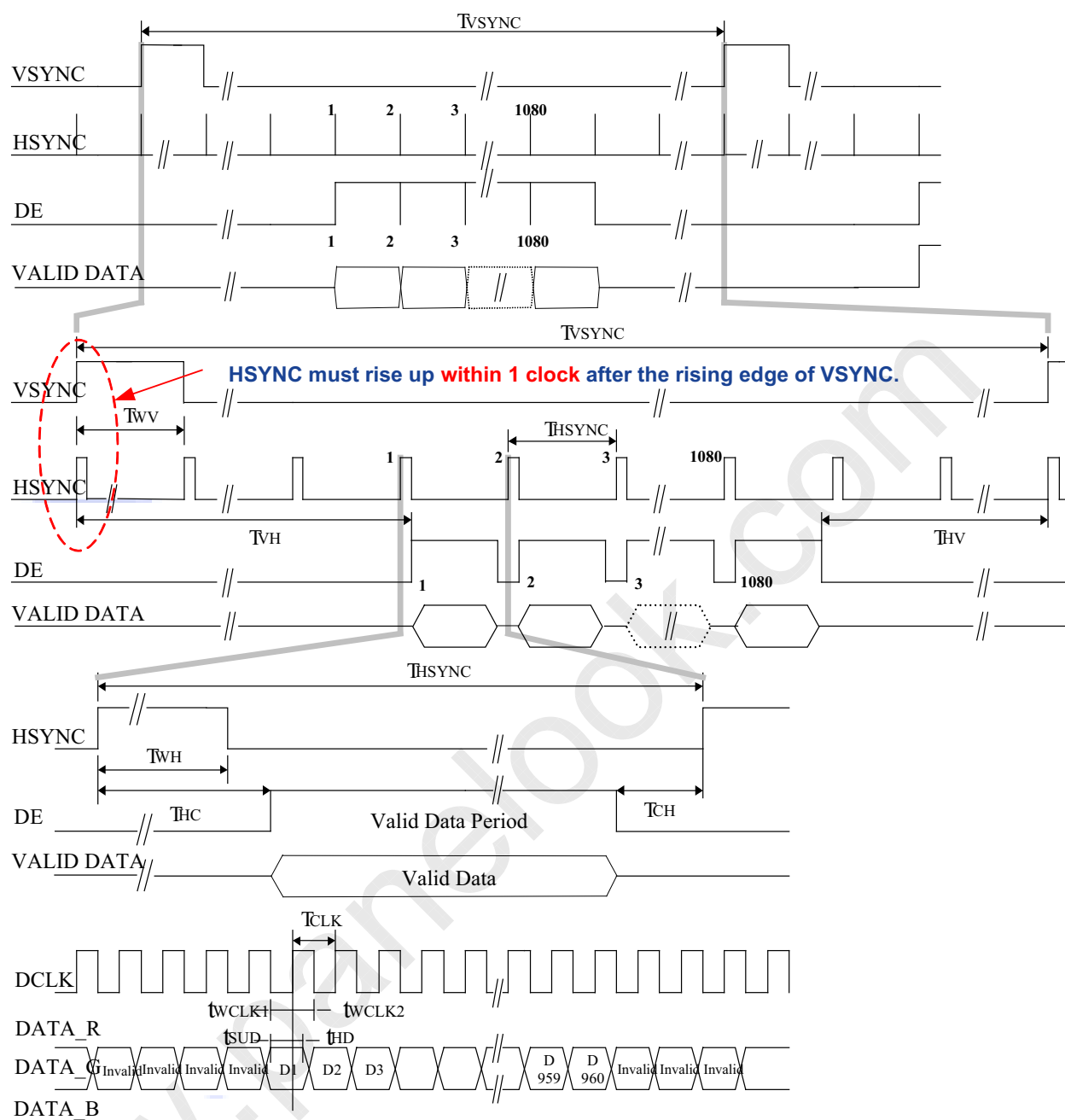


Figure-16. Video Input Signal Timing Chart

10.9 LVDS Connection Specifications

The following figure shows the connection specifications and signal assignments of the LVDS interface IC. Do not connect or disconnect the LVDS connector when the system power is on. Otherwise, the LVDS interface IC could be damaged.

LVDS Interface Connection

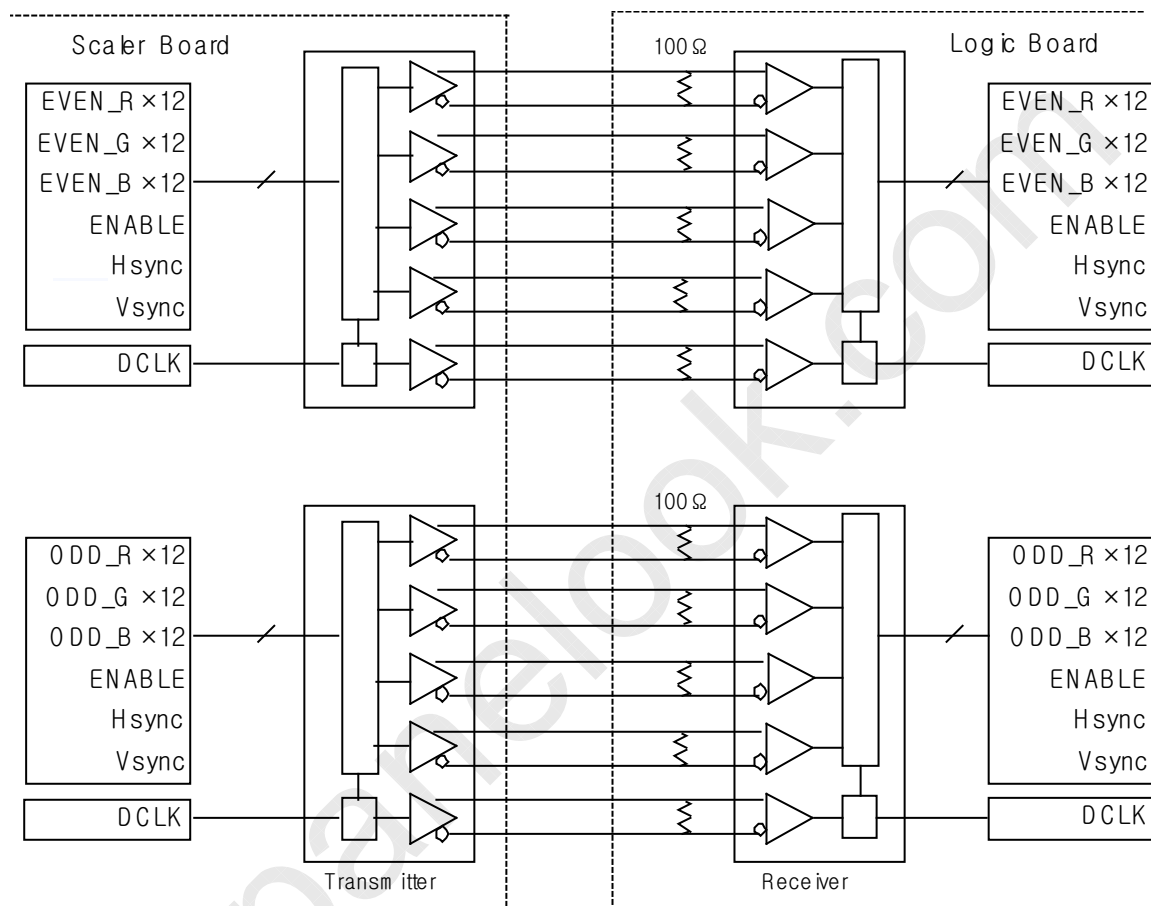


Figure-17. LVDS Interface Connection

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10.10 I2C Interface Conditions

1) Synopsis

This module is capable of I2C communication. (bus serial data communication)

The image processing board may communicate with the module to vary the default register settings open to customers to affect several display characteristics.

Below are the basic parameters for I2C communication.

No	Parameter	Specifications
1	Recommended Transfer Rate	100 kbps
2	Device Status	Slave Receiver
3	Slave Address	66(Write), 66(Read)

2) I2C-Ready Signal

I2C control is available only when the I2C-Ready signal is 'High'.

The I2C-Ready signal is assigned to the pin number 1 of CN2010

3) Data Validity

The amount of the transferred data per one clock cycle is a single bit. Transferred data on SDA(I2C data) is recognized to be valid when SCL(I2C clock) is high.

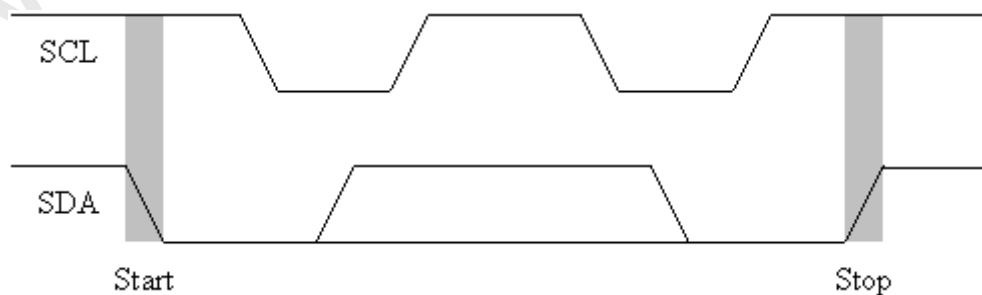


4) Start & Stop Condition

The Start /Stop condition is generated only by Master (=Image B'D). Before the start condition or after the stop condition, a SDA cannot be recognized as valid data.

Start condition SCL high & SDA transition from H to L

Stop condition SCL high & SDA transition from L to H

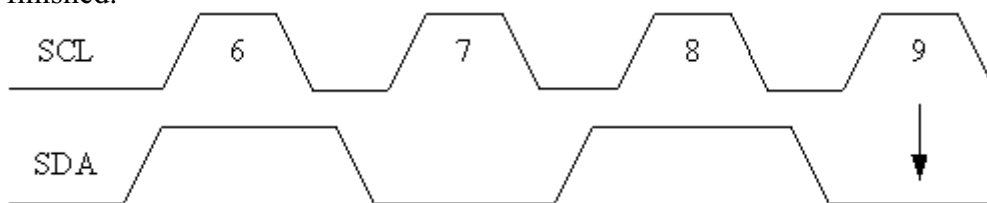


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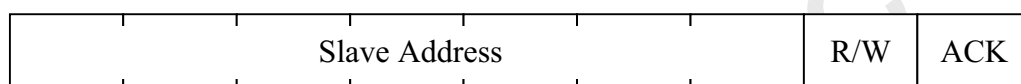
5) Acknowledge

When Master (=Image B'D) needs to stop reading data, the master should deliver NO ACK signal to the slave via SDA. Slave (=PDP) responds by ACK once 8-bit transfer is finished.



6) 7-Bit Addressing for Device address(with example of CC or CD)

Master could select a slave device and read/write operation by 7-bit slave address followed by a R/W bit (H=Read procedure, L=Write procedure).



7) 16-Bit Mode

The basic I2C format (8-bit (Byte)) is expanded by 16-bit (Word) in the module. Therefore, the I2C architecture of the module supports 7-bit slave addressing, 16-bit addressing and 16-bit data transfer (Refer to 'Write & Read Operation').

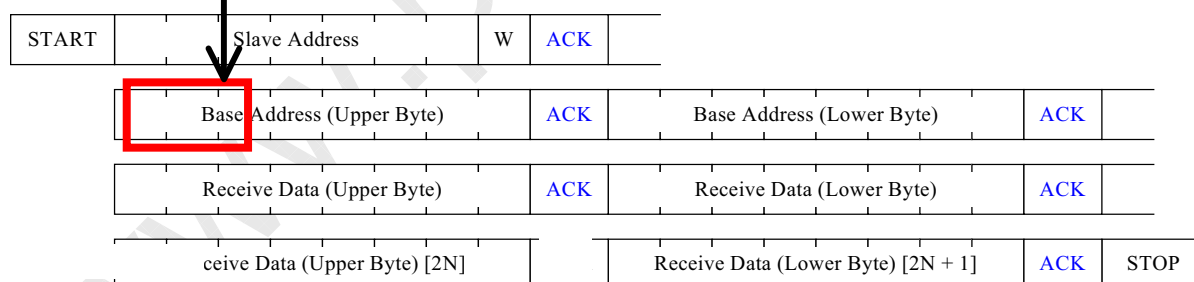
8) Data Transfer Sequence (Write)

Note 1: Black letters mean master (=Image B'D)'s bus occupation.

Note 2: Blue letters mean slave (=PDP module)'s bus occupation.

Note 3: Option Bit = 01: ROM, 10: RAM, 11: both Memory(ROM and RAM)

If ROM mode is very slow, it is impossible to use normal I2C communication. **The image board can only use RAM mode.**



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9) Data Transfer Sequence (Read)

Note 1: In advance, master should initialize writing sequence by giving base address and stop condition.

Note 2: After start condition and slave addressing, master could receive data from slave.

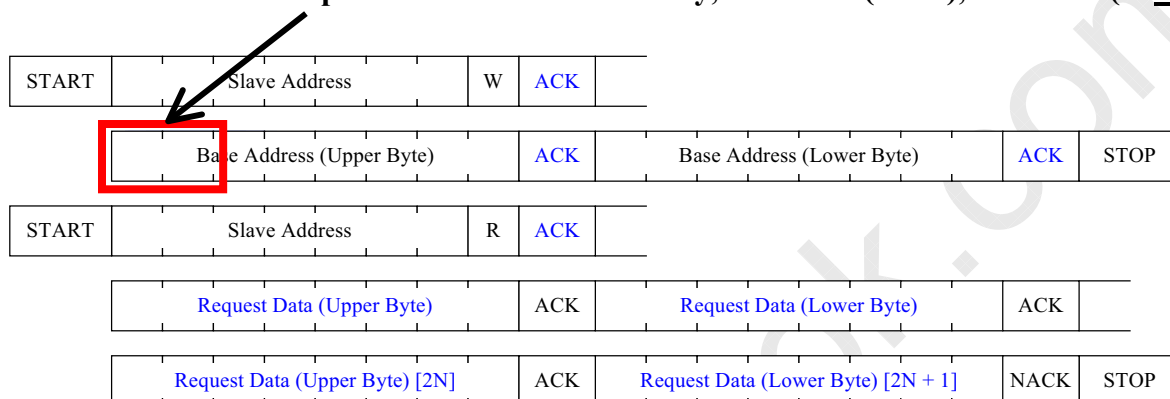
Note 3: Master should give acknowledge at everytime 8-bit data is received.

Note 4: 'No acknowledge' could make master give stop condition on bus. Therefore, NACK is used for master to stop receiving data from slave.

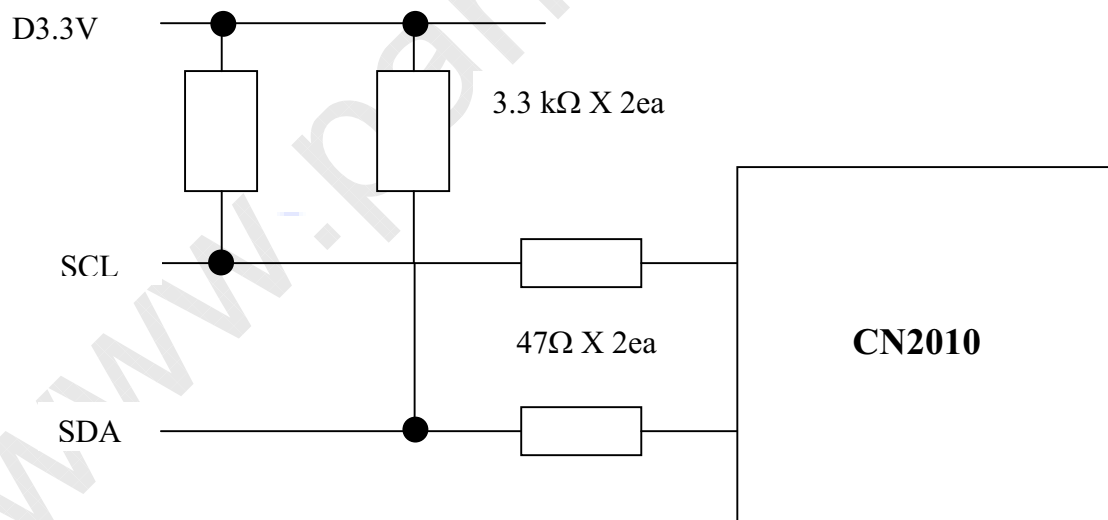
Note 5: Black letters mean master (=Image B'D)'s bus occupation.

Note 6: Blue letters mean slave (=PDP Module)'s bus occupation.

Note 7: Option Bit = 11: both memory, 01: ROM (512K), 10: RAM (in ASIC)



10) I2C Interface Circuit



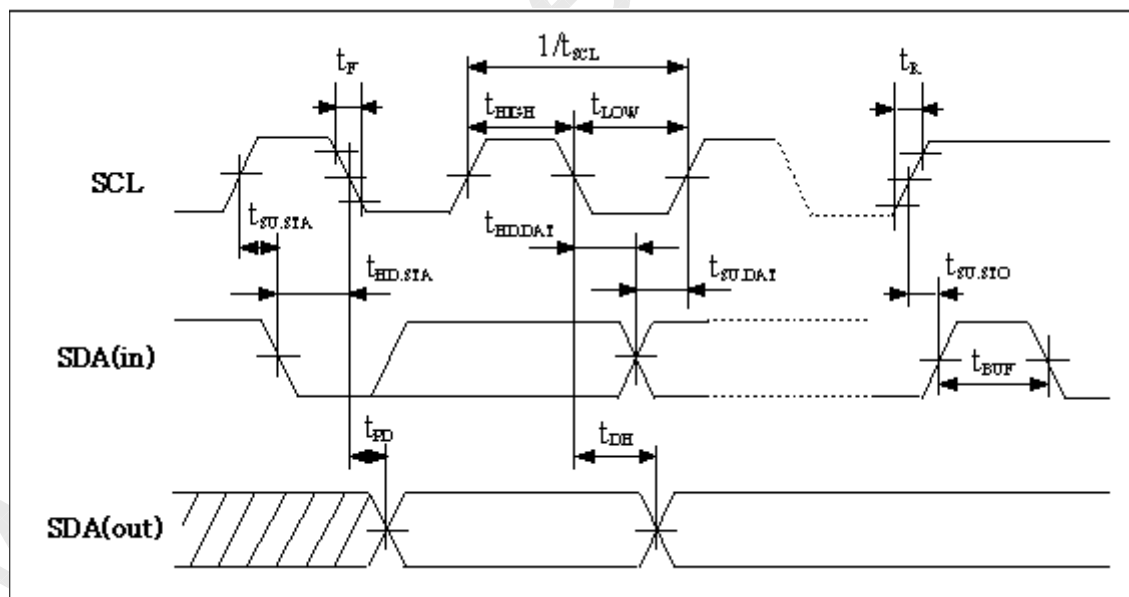
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11) I2C Bus Timing Specifications

* Refer to the following data merely as sample data.

No	Item	Symbol	Standard			
			Min.	Typ.	Max.	Module
1	SCL Input Frequency	f_{SCL}	-	100	200	kHz
2	SCL Input "HIGH" Period	t_{HIGH}	4.0	-	-	μs
3	SCL Input "Low" Period	t_{LOW}	4.7	-	-	μs
4	Start Condition Set Up Time	$t_{SU,STA}$	4.7	-	-	μs
5	Start Condition Hold Time	$t_{HD,STA}$	4.0	-	-	μs
6	Data Input Set Up Time	$t_{SU,DAT}$	0.25	-	-	μs
7	Data Input Hold Time	$t_{HD,DAT}$	5	-	-	μs
8	Stop Condition Set Up Time	$t_{SU,STO}$	4.0	-	-	μs
9	Data Output Delay Time	t_{PD}	0.1	-	-	μs
10	Data Output Hold Time	t_{DH}	0.1	-	-	μs
11	SDA Bus Free Time	t_{BUF}	4.7	-	-	μs
12	SCL, SDA Input Rising Time	t_R	-	-	1.0	μs
13	SCL, SDA Input Falling Time	t_F	-	-	0.3	μs
14	SCL, SDA Line Capacitor	C_b	-	50	100	pF





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10.11 Connector Specifications

Connector Name	Pin #	Signal Name
CN2010	1	ARM_INIT_DONE
	2	N.C.
	3	N.C.
	4	N.C.
	9	TxOOUT0-/RxOIN0-
	10	TxOOUT0+/RxOIN0+
	11	TxOOUT1-/RxOIN1-
	12	TxOOUT1+/RxOIN1+
	13	TxOOUT2-/RxOIN2-
	14	TxOOUT2+/RxOIN2+
	15	TxOCLKOUT-/RxOCLKin-
	16	TxOCLKOUT+/RxOCLKin+
	17	TxOOUT3-/RxOIN3-
	18	TxOOUT3+/RxOIN3+
	19	TxOOUT4-/RxOIN4-
	20	TxOOUT4+/RxOIN4+
	21	TxOOUT5-/RxOIN5-
	22	TxOOUT5+/RxOIN5+
	23	TxEOUT0-/RxEIN0-
	24	TxEOUT0+/RxEIN0+
	25	TxEOUT1-/RxEIN1-
	26	TxEOUT1+/RxEIN1+
	27	TxEOUT2-/RxEIN2-
	28	TxEOUT2+/RxEIN2+
	29	TxECLKOUT-/RxECLKin-
	30	TxECLKOUT+/RxECLKin+
	31	TxEOUT3-/RxEIN3-
	32	TxEOUT3+/RxEIN3+
	33	TxEOUT4-/RxEIN4-
	34	TxEOUT4+/RxEIN4+
	35	TxEOUT5-/RxEIN5-
	36	TxEOUT5+/RxEIN5+
	37	SCL
	38	SDA
	39	IMG_EINT
	40	Rx
	41	Tx

NOTES:

1. CN2010 connector is located in a logic board.
2. Pin to Pin pitch of connector CN2010 is 1.25 mm.
3. The length of LVDS cable to CN2010 is recommended to be no longer than 25.0 cm.
4. Pin numbering order : Left to right when viewed from rear of the module
5. All the other pins are GND.
6. Reserved for factory use only. This pin should be disconnected in case of customer's use.
7. IMG_EINT is for the use of NO-LVDS-NO-PICTURE. If not used, it should be N.C.



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11.REGISTER MAP

11.1 Address Map

- I2C Slave Address Write: 66 (hex), Read: 66 (hex)

OPEN REGISTERS																				
ITEM	I2C Address	R/W	NAME	BIT MAP																DEFAULT
				D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	
System	8100h	R/W	R_SYNC_POL																	0030h
	8128h	R/W	R_DATA_INPUT_MODE																	2000h
Pattern	8114h	R/W	R_PATT_SEL																	0000h
		R/W	R_SYS_CLK_SEL																	
APC	89C0h	R/W	APCO																	0000h
	89C2h	R/W	R_HOLD_TIME																	0F00h
	89C6h	R/W	ASLG_SW																	8000h
		R/W	ASLG																	

NAME	DESCRIPTION
R_SYNC_POL	External SYNC Polarity Select ['1':Active High,'0':Active Low] *Data enable's polarity is set active high
R_DATA_INPUT_MODE	Input data mode select (000b : 12bit, 001b : 11bit, 010b : 10bit, 011b : 9bit, 100b : 8bit, 101b : VESA 8bit, 110b : JEIDA 8bit, 111b : NS 10bit, 1000b : JEIDA 10 bit, others : 12bit)
R_PATT_SEL	Internal Test Pattern select [0000h~001Fh Recommended]
R_SYS_CLK_SEL	Internal Pattern Enable [1=ON, 0=OFF]
APCO	APC OFFSET Control
R_HOLD_TIME	Slow APC Data transition time
ASLG_SW	ASL Constant Operatoion on/off SW ['1' : on, '0' : off]

[Note]

- Only the addresses shown above are allowed for access. An access to any other address may lead to an abnormal system down or permanent damage to the module.

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11.2 Detailed Settings

Address	Data Bit	Symbol	Item / Function	Setting [hex]			No te
				Range	Initial		
					NT	PAL	
8114(NT) 9114(PAL)	0~5	R_PATT_SEL	Pattern Select Patterns below are valid when IE (Internal clk or External clk) is set to ‘1’. 00: Full Window (Black) 01~04: Full Window (White,Red,Green,Blue) 05 : 1 point Box(White, Windows size) 06~09: 9 Point Box (White,Red,Green,Blue) 0A : 1% Window , 0B: Color Bar, 0C : Half Gray, 0D: Cross Hatch, 0E : Dot Array, 0F : 3% Window 10~13 : Gray Bar (Horizontal, Vertical) 14~16: Vertical Ramp Pattern (Stay, Scroll) 17~19: Horizontal Ramp Pattern (Stay, Scroll) 1A : Horizontal Gray Color Bar 1B : Dot Array, 1C : IRE, 1D : Scroll, 1E : Half Gray, 1F : Moving Scroll	00~1E	00	00	*(a)
89DA(NT) 99DA(PAL)	0~7	PLG	Power Lower Gain Control Control the power lower level of PDP module.	00~FF	80	80	*(b)
89C6(NT) 99C6(PAL)	8~15	ASLG	ASL Gain Control the ASL Gain of the module.	00~FF	80	80	*(b)
89C6(NT) 99C6(PAL)	0	ASLG_SW	ASL Gain Operation on/off S/W ‘1’ = On, ‘0’ = Off	0~1	00	00	*(b)
89C0(NT) 99C0(PAL)	0~8	APCO	APC Offset Level Adjusts peak luminance to customer’s needs.	00~C7	00	00	*(b)

*(a) Please access the above addresses for test use only.

For ordinary operating conditions, it is advised not to change the default settings of the addresses.

*(b) APCO , ASLG, PLG is used for controlling the "Brightness and Power Mode" of the module. For details, refer to the Chapter 6. about Power Consumption(6.7).



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12. INPUT POWER VOLTAGE SPECIFICATIONS

12.1 Electrical Characteristic Overview

Output Name	Nominal Voltage(V)	Average output current			(*1)Load Regulation(%)	(*2)Variable Range(V)	Ripple & Noise (Dynamic load)	Remark
		Min.	Nor.	Max				
Vs	+205V	0.1A	2.5A	4.5A	±2	190V~220V	1000mVp-p (5000mVp-p)	Sustain voltage
Va	+65V	0.1A	1.0A	3.5A	±2	50V~80V	1000mVp-p (1000mVp-p)	Address voltage
Vscan	-190V	0.01A	0.2A	0.5A	±5	-160V~200V	1000mVp-p (3000mVp-p)	Scan voltage
Ve	+120V	0.01A	0.1A	0.3A	±5	100V~140V	1000mVp-p (5000mVp-p)	Bias voltage
Vg	+15V	0.1A	0.5A	3.0A	±5	Fixed	200mVp-p	Drive gate in FET
D5.3V	+5.3V	0.1A	3.5A	5.0A	±5	Fixed	100mVp-p	Drive TTL in X,Y driving, Logic

*1. This means nominal voltage stability when current is changed from min to max.

*2. The output voltages for Vs, Va,Vscan,Ve could be varied within variable range by feedback variable resistors.

*3. This spec guaranteed when no changed luminance and power consumption spec

■ Above voltage levels are nominal value. They are adjustable to drive Panel.

12.2 Electrical Characteristic Overview for Image Board

Output Name	Nominal Voltage(V)	Average output current			(*1)Load Regulation(%)	(*2)Variable Range(V)	Ripple & Noise (Dynamic load)	Remark
		Min.	Nor.	Max				
D5.3V	+5.3V	0.1A	2.5A	4.0A	±5	Fixed	100mVp-p	Image
12V	+12V	0.01A	1.0A	2.5A	±5	Fixed	200mVp-p	Image. Fan input
Vamp	+18V	0.01A	0.5A	3.0A	±5	Fixed	200mVp-p	Sound
VT	+33V	0.001A	0.005A	0.006A	±10	Fixed	-	Tuner
STBY	+5.2V	0.01A	0.5A	4.5A	±3	Fixed	100mVp-p (300mVp-p)	Standby



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12.3 Pin assignment of connectors for Power Supply

Location No.	CN4000	CN5015	CN2001	CN2501,CN2708
Function	X-Main	Y-Main	Logic Main	Logic Buffer
No. of Pin	9 pins	10 pins	10 pins	5 pins
Connector Type	Molex 35313-0910	Molex 35313-1010	Yeon-Ho 20022WR-10AML	Yeon-Ho YAW396-05F
Pin No.	Pin Name	Pin Name	Pin Name	Pin Name
1	D5.3V	Vs	D5.3V	D5.3V
2	Vg	Vs	D5.3V	RTN
3	RTN	RTN	D5.3V	RTN
4	RTN	RTN	RTN	Va
5	Ve	N.C	D5.3V	Va
6	RTN	RTN	RTN	
7	RTN	Vscan	Ps-On(*2)	
8	Vs	RTN	RTN	
9	Vs	Vg	Vs-On(*1)	
10		D5.3V	RTN	

*1. This is a signal from a logic main b'd to PSU. (High : 2.8V, Low : 0V)

This is marked at 3. Power Applying Sequence.

*2. This is a signal(Active low) from image board to logic main. (High : 3.3V, Low : 0V)



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12.4 Pin assignment of connectors for Image Board

Location No.	CN801		
Function	Image		
No. of Pin	24 pins		
Connector Type	Yeon-Ho SMW200-24C		
Pin No.	Pin Name	Pin No	Pin Name
1	PS_ON	2	VT
3	STBY	4	RTN
5	RTNAMP	6	RTNAMP
7	18Vamp	8	18VAMP
9	RTN	10	RTN
11	RTN	12	RTN
13	D5.3V	14	D5.3V
15	D5.3V	16	D5.3V
17	RTN	18	RTN
19	12V	20	RTN
21	12V	22	12V
23	FAN_ON	24	FAN_D

12.5 Pin assignment of connectors for AC Input

Location No.	CN800
Function	AC input
No. of Pin	5 pins
Connector Type	Molex 35313-0450
Pin No.	Pin Name
1	NUETRAL
2	NUETRAL
3	N/C
4	LIVE
5	LIVE

*1. Nominal Input Voltage is AC100V to AC240V. (Input Voltage Variation Range is AC85V to AC269V)

*2. Nominal Frequency is 50 / 60 Hz. (Frequency Variation Range is 47Hz to 63Hz)

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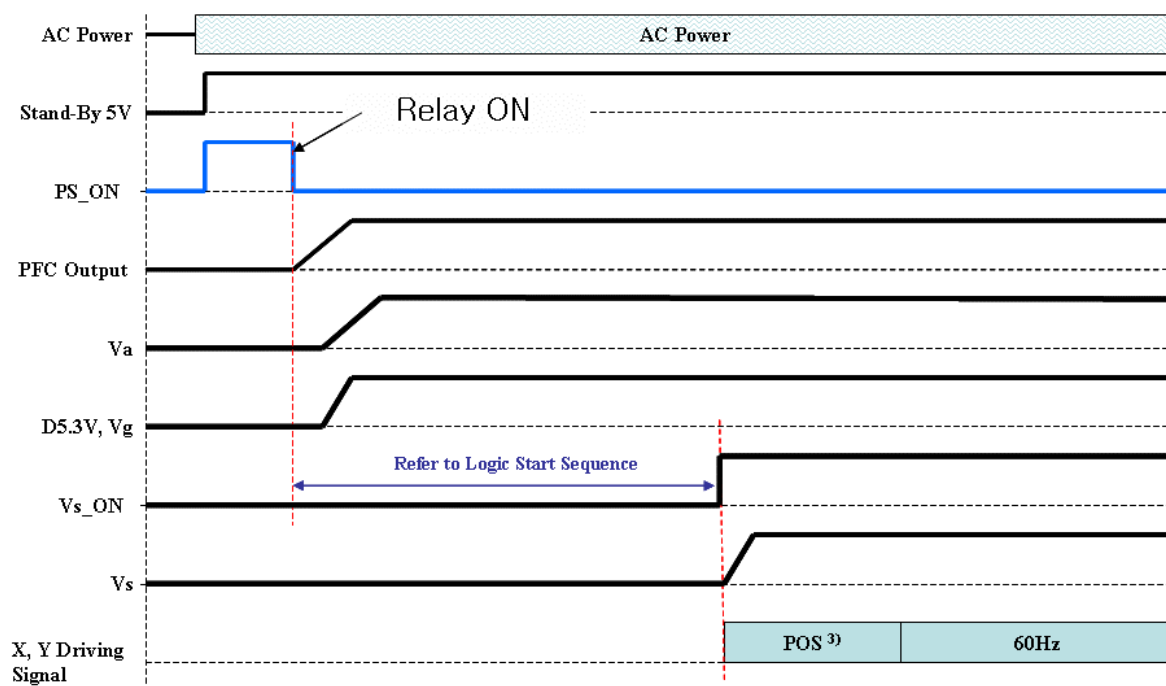
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12.6 Power Applying Sequence

12.6.1 Relay_on Sequence



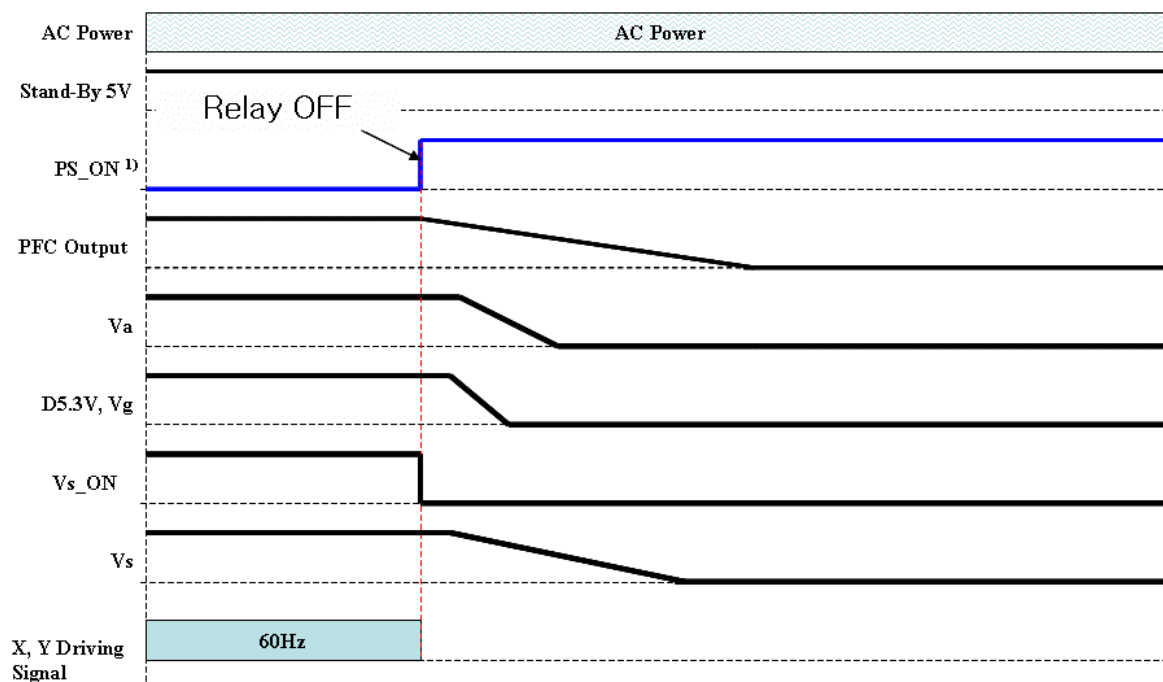
- *1. Reference value
- *2. D5.3V needs to start with 5~50ms rising time. At least 500mA is needed for rising time.
- *3. Vs_on signal is output from Logic board to PSU.
- *4. Vs should be enabling with Vs_on signal(Active High) from Logic.
- *5. Vs should be always higher than Ve while D5.3V is alive.
- *6. I2C Ready signal is output from Logic board to Image board.
- *7. POS : Power ON Sequence.

- The voltage of Vs, Vscan, Ve must build up within 1300ms after Vs_on. Because the data of Logic is output at 1300ms after Vs_on.

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12.6.2 Relay_off Sequence

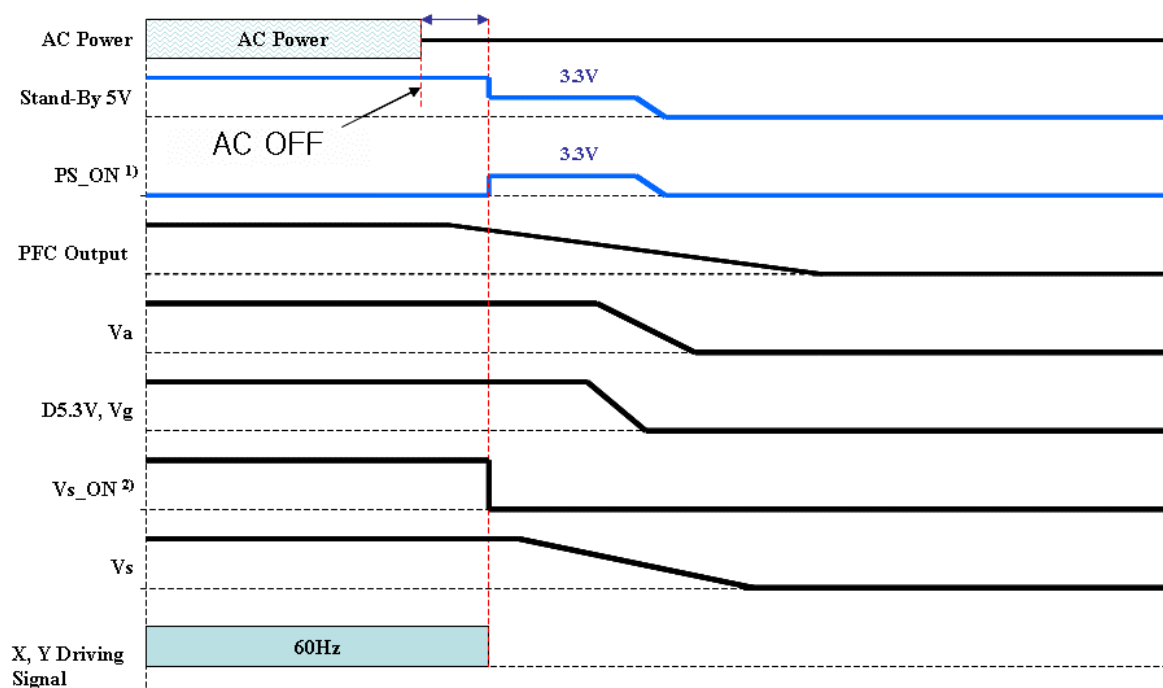


- *1. D5.3V discharge should be faster than other voltages. D5.3V should discharge before Vg voltage level is 11V and Vs voltage level is lower than Ve.
- *2. Before turning the 5.3V off, we recommend blanking image data for 48ms~80ms, but hold Vsync, DCLK. This is good for the defect of first(power on) discharge.
- *3. Either spontaneous or active discharge is available for PFC, Vs, Va, Vscan, Ve. as long as D5.3V has been discharged before other voltages.

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12.6.3 AC_off Sequence



*1. D5.3V discharge should be faster than other voltages. D5.3V should discharge before Vg voltage level is 11V and Vs voltage level is lower than Ve.

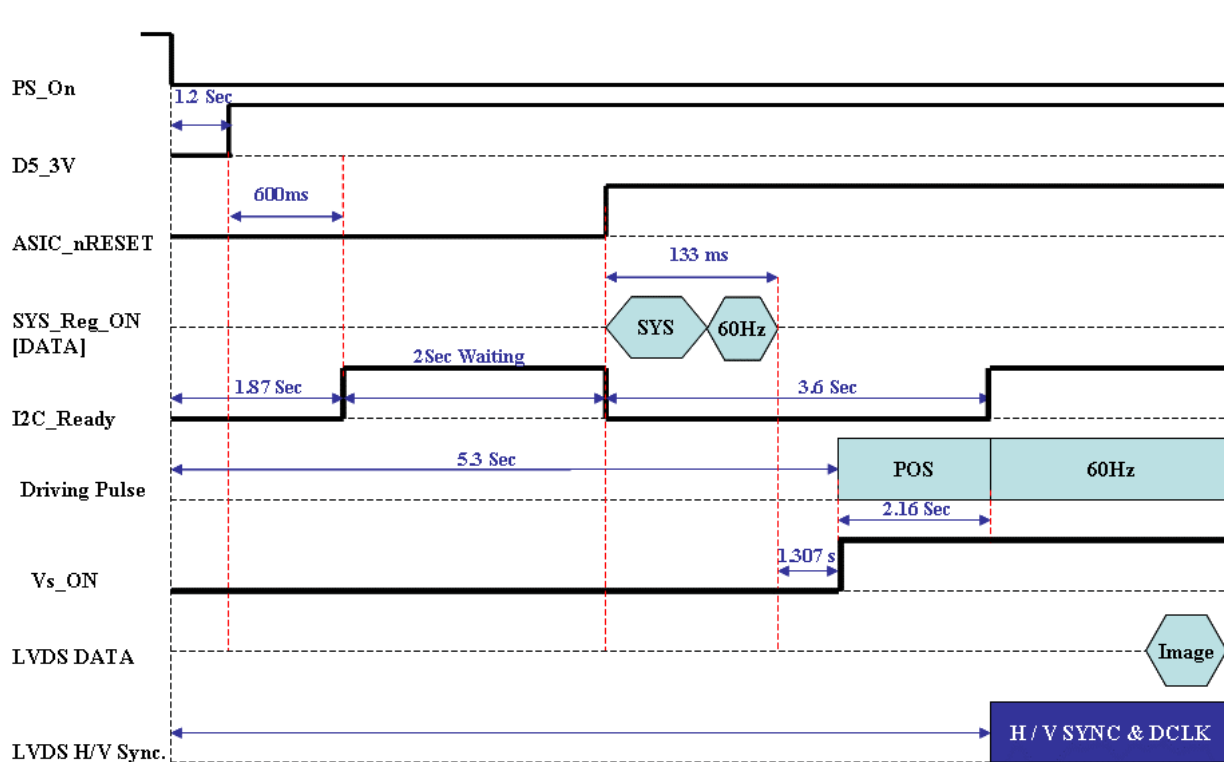
*2. Before turning the 5.3V off, we recommend blanking image data for 48ms~80ms, but hold Vsync, DCLK. This is good for the defect of first(power on) discharge.

*3. Either spontaneous or active discharge is available for PFC, Vs, Va, Vscan, Ve. as long as D5.3V has been discharged before other voltages.

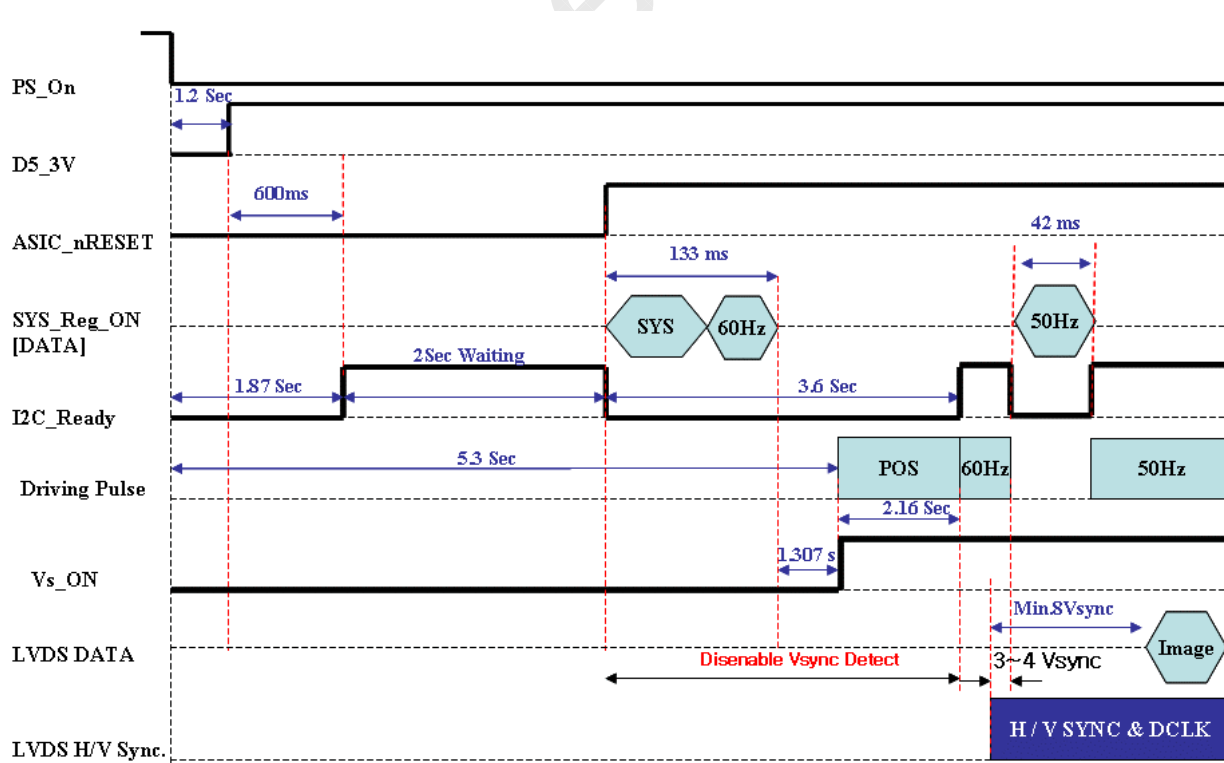
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12.6.4 Logic Start Sequence – Controlled by Vsync, 60Hz



12.6.5 Logic Start Sequence – Controlled by Vsync, 50Hz



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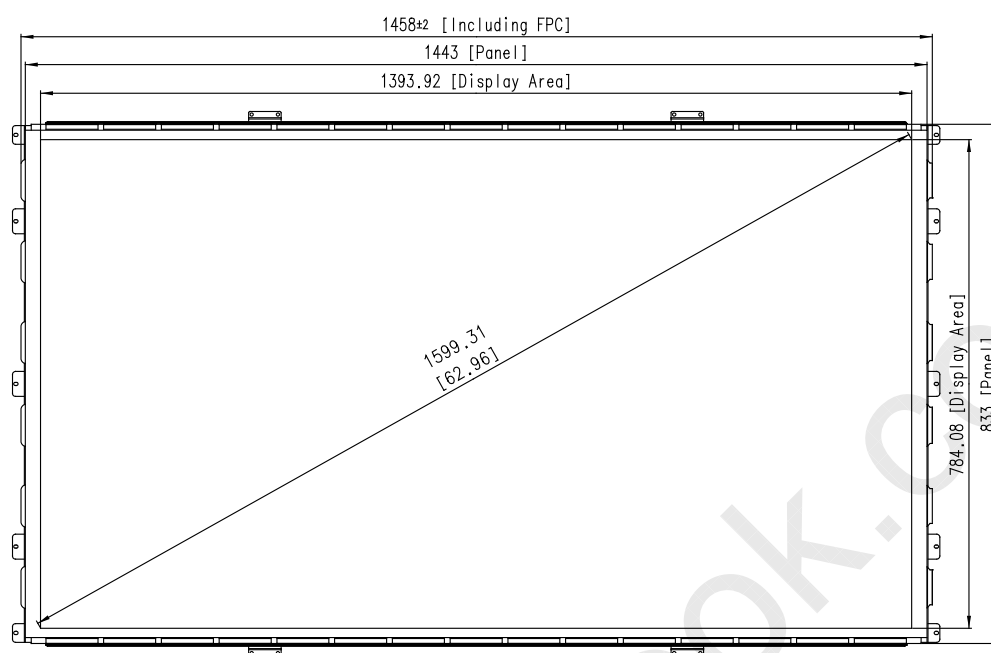
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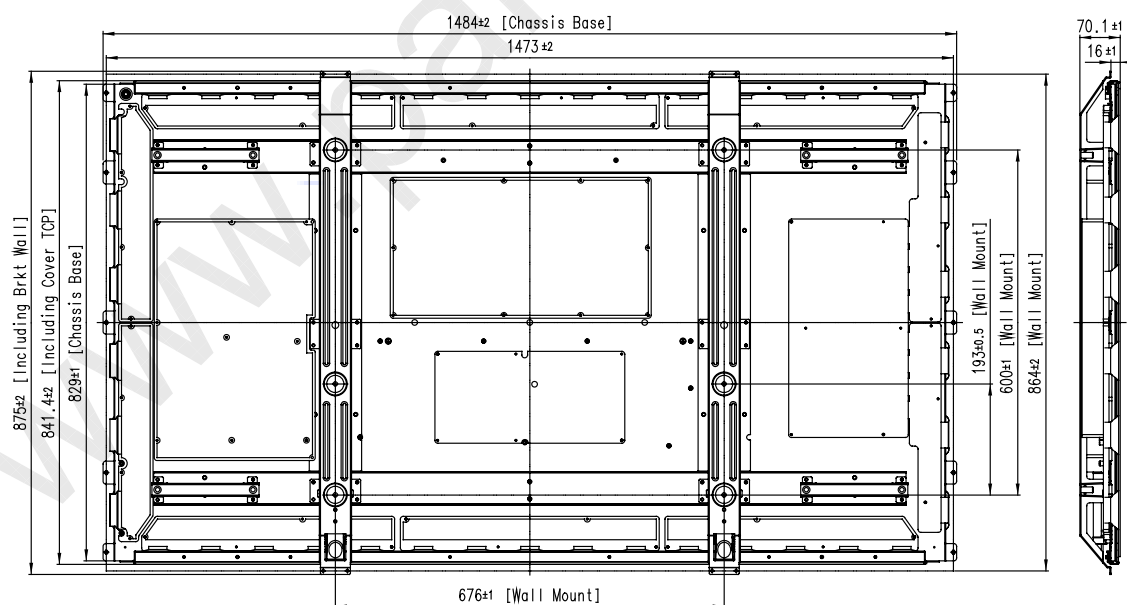
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13. MECHANICAL DIMENSION DRAWING

13.1 Front Side



13.2 Rear Side



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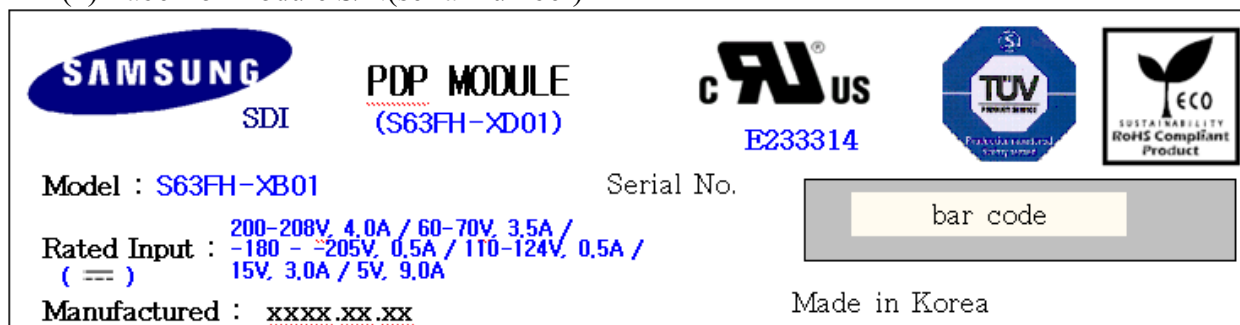
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14. LABEL

14.1 Label Type

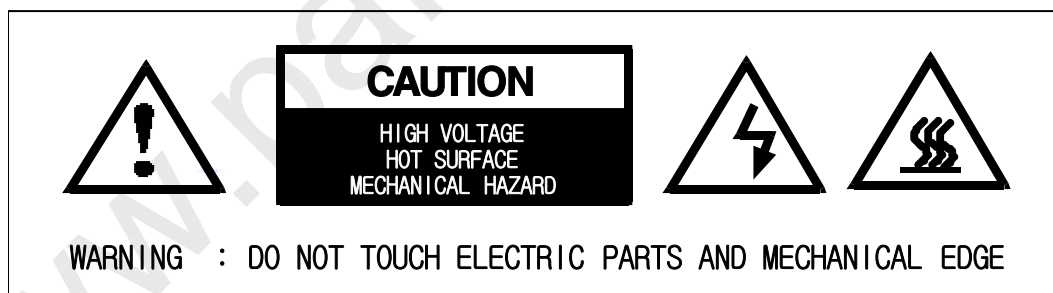
(1) Label for module S/N(serial number)



(2) Label for Operating Voltages

NTSC		✓ NTSC/PAL	
Va	Vsc	Vs	Ve

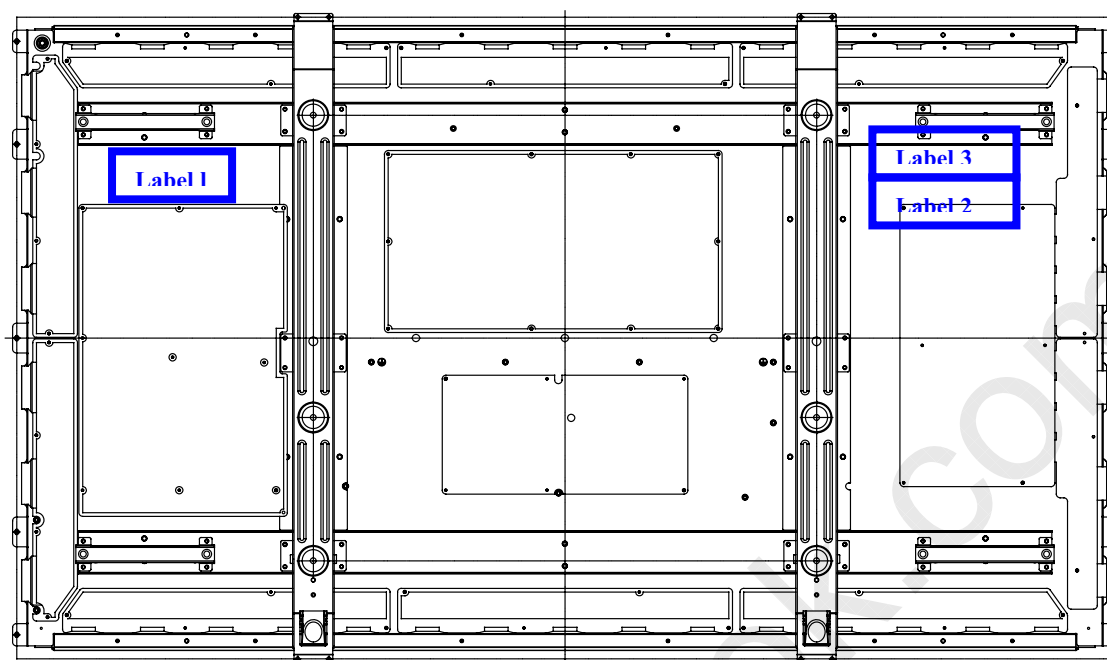
(3) Caution/Warning Label



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14.2 Label location



【 Notes 】

1. Label-1 is for the module S/N.
2. Label-2 is for the operating voltage specification.
3. Label-3 is for caution and warning.

15.1 Packing Dimension and Parts List

- | No. | ITEM |
|------------|-------------------------|
| 1 | CHEMICALS |
| 2 | BAND-PP |
| 3 | TAPE-FILAMENT |
| 4 | TAPE-ACETATE |
| 5 | LOCKET-BAND,CLIP |
| 6 | CUSHION-SET |
| 7 | PACKING-MODULE |
| 8 | PACKING CASE-MID |
| 9 | PACKING CASE-TOP |
| 10 | PACKING CASE-BOT |
| 11 | PALLET(PAPER) |
| 12 | BAG SVC |
| 13 | LABEL-INSPECTION |
| 14 | GUIDE-PACK |
| 15 | SCREW-MACHINE |

This exploded view diagram illustrates the assembly of a container. The components are numbered as follows:

- 1**: Base plate (orange)
- 2**: Side panel (orange)
- 3**: Top panel (orange)
- 4**: Front panel (orange)
- 5**: Back panel (orange)
- 6**: Top panel (orange)
- 7**: Front panel (orange)
- 8**: Middle panel (orange)
- 9**: Top panel (orange)
- 10**: Base plate (orange)
- 11**: Base plate (orange)
- 12**: Top panel (orange)
- 13**: Base plate (orange)
- 14**: Top panel (orange)
- 15**: Base plate (orange)

16. RELIABILITY

16.1 MTBF Value

Mean Time Between Failure is dependent on the overall module design.

MTBF : 60,000hours (excluding electrolytic capacitors)

※ Condition : 25℃, Used moving Picture Signal

16.2 Expected Service Lifetime

#1. Definition

The expected service lifetime is defined by the following two categories.

And the life time is defined by either (1) or (2), whichever occurs first.

(1) The white color luminance level becomes the half (50%) of its initial value, which is determined by phosphor characteristics of the panel.

(2) The number of display cell defects increases to twice the values described in this specification.

#2. Test condition and life time

The expected service life time varies depending on the display conditions set forth below.

(1) Full screen white color display

Life time : 60,000 hours

Test condition : 8Hr/Day



16.3 Disclaimer

This Specification stipulates the final and comprehensive requirements for the respective products hereof. Beyond this Specification, it is the responsibility of the customer to explicitly disclose any additional requirements, information or reservations regarding these requirements to Samsung SDI prior to implementation, where any and all disclosures of the customer shall be with an authorized representative of Samsung SDI in writing. Samsung SDI shall not be responsible for safety, performance, functionality or compatibility of the system with which the Samsung SDI-supplied components are integrated unless such features have been expressly communicated and described in the Specification. SAMSUNG SDI MAKES NO GUARANTY OR WARRANTY, EXPRESS OR IMPLIED, INCLUDING BUT NOT LIMITED TO MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE, TO ANY PARTY. Moreover, any party should do their own due diligence regarding these requirements prior to implementation

16.4 Certificate

We verify that we never use or include the restricted substances under the level 1 of SEC's management requirement (SS-00259) in parts and components, subsidiary material, materials used for unit parts, and packing materials or substances added during manufacturing process.



17. WARNING / CAUTION / NOTICE

TO PREVENT POSSIBLE DANGER, DAMAGE, AND BODILY HARM, PLEASE CONSIDER AND OBSERVE ALL WARNINGS AND CAUTIONS CONTAINED IN THIS PARAGRAPH.

17.1 Warning

If you do not consider the following warnings, it could result in death or serious injury

- (1) The Module is controlled by high voltage about 350V. If you need to handle the Module during operation or just after power-off, you must take proper precautions against electric shock and must not touch the drive circuit portion and metallic part of Module within 5 minutes. The capacitors in the drive circuit portion remain temporarily charged even after the power is turned off. After turning off the power, you must be sure to wait at least one minute before touching the Module. If the remain voltage is strong enough, it could result in electric shock.
- (2) Do not use any other power supply voltage other than the voltage specified in this product specifications. If you use power voltage deviated from the specifications, it could result in product failure.
- (3) Do not operate or install under the deviated surroundings from the environmental specification set for the below; in moisture, rain or near water-for example, bath tub, laundry tub, kitchen sink; in a wet basement; or near a swimming pool; and also near fire or heater - for example, near or over radiator or heat resistor; or where it is exposed to direct sunlight; or somewhere like that. If you use the Module in places mentioned above, it could result in electric shock, fire hazard or product failure.
- (4) If any foreign objects (e.g. water, liquid and metallic chip or dust) entered the Module, the power supply voltage to the Module must be turned off immediately. Also, never push objects of any kind into the Module as they may touch dangerous voltage point or make short circuits that could result in fire hazard or electric shock.
- (5) If smoke, offensive smell or unusual noise should come from the Module, the power supply voltage to the Module must be turned off immediately. Also, when the screen fails to display any picture after the power-on or during operation, the power supply must be turned off immediately. Do not continue to operate the Module under these conditions.
- (6) Do not disconnect or connect the Module's connector while the power supply is on, or immediately after power off. Because the Module is operated by high voltage, and the capacitors in drive circuit remain temporarily charged even after the power is turned off. If you need to disconnect or reconnect it, you have to wait at least one minute after power off.
- (7) Do not disconnect or connect the power connector by a wet hand. The voltage of the product may be strong enough to cause an electric shock.

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- (8) Do not damage the power cable of the Module, also do not modify it.
- (9) When the power cable or connector is damaged or frayed, do not use it.
- (10) When the power connector is covered with dust, please wipe it out with a dry cloth before power on.



17.2 Caution

If you do not consider the following cautions, it may result in personal injury or damage in property.

- (1) Do not set the Module on an unstable, vibrating or inclined place. The Module may fall or collapse and it may cause a serious injury to a person, and/or damage to the product.
- (2) If you need to remove the Module to another place, you must turn off the power supply and detach the interface cable and power cable from the Module beforehand, and watch your steps not to step on the cables during the operation. If the cables are damaged during the transport, it may result in fire hazard or electric shock. Also if the Module is dropped or fallen, it may cause a serious injury to a person and /or damage to the product.
- (3) When you draw or insert the module's cable, you must turn off the power supply and do it (with) holding the connector. If you forcibly draw the cable, the electric wire in the cable can be exposed or broken. It may result in fire hazard or electric shock.
- (4) When you carry the Module, it should be done with at least two workers in order to avoid any unexpected accidents.
- (5) Be careful not to touch the panel glass surface while the PDP module is operating because there is a possibility of getting a burn injury due to its very high temperature.
- (6) The Module has a glass-plate. If the Module is inflicted with excessive stress - for example; shock, vibration, bending or heat-shock, the glass plate could be broken. It may result in a personal injury. Also, do not press or strike the glass surface.
- (7) If the glass panel was broken, do not touch it with bare hand. It may result in a cut injury.
- (8) Do not place any object on the glass panel. It may be the cause of the scratch or break of the glass panel.
- (9) Do not place any object on the Module. It may result in a personal injury due to fall or drop.
- (10) PDP is a product, which generates heat during operation. Therefore, do not use the materials which make corrode the PDP module by the chemical reaction that takes place in high temperature and humidity conditions.
- (11) Exposing to corrosive gases or contact with the materials, which may cause corrosions, could lead to chemical reactions that will adversely affect on the device. If you were to use the PDP in such conditions, consider ways to avoid such exposure or to protect the PDP module.



17.3 Notice

When you apply the Module to your system or handle it, you must make sure to follow the notices set forth below.

□ *Notice to your system design*

- (1) The Module radiates the infrared rays of between 800 and 1000 nm. It may bring an error in operating the IR-remote controller or another electric system. Please consider (to) providing the IR absorb filter in your system, and evaluating it.
- (2) The Module has a high-voltage switching circuit and a high-speed clock circuit. Therefore, you have to apply and evaluate the EMC consideration of your system.
- (3) The Module has a glass plate. In your mechanical design, please (consider to) avoid any excessive shock and stress to the glass surface. Also be careful not to damage the exhaust pipe at the corner of glass plate. If the glass plate and exhaust pipe are damaged, the &Module may fail.
- (4) Since PDP module is controlled by high voltage, all voltage should be discharged immediately after the power is turned off.
- (5) PDP module generates heat during operation. Heatproof design (radiation and ventilation) should be considered from design stage. If the PDP module is used out of the specified temperature range, it can result in a defect.
- (6) The ventilation design in your system should have a back-cover that is able to prevent moisture and dust from getting into the inside of the electric circuit, because the Module has high-density electric parts with high-voltage. If the driver circuit has condensation or dusts, it may cause a short circuit or dielectric breakdown.
- (7) If an excessive stress (more than specified absolute maximum ratings in the voltage, current, temperature etc.) is applied to the PDP module, it could cause a serious damage. Do not use the module out of the ratings.
- (8) Recommended usage condition of PDP module is limited to the general usage. Within this range, the electrical characteristics of all components are guaranteed. Semiconductors should be used within specified usage range. Usage out of the range will result in decrease of reliability and defects in devices. If the usage or operating condition is out of specification specified on the data sheet, it will be not covered from the guaranteed range. If you were to use the product in the environment not stated in the list, you should consult with SAMSUNG SDI prior to the usage.
- (9) When the PDP module shows fixed pattern, there are possibilities of having the image retention (the difference in brightness between turned-on and turned-off portion of screen due to the different temperature and discharge) and image sticking (the difference in brightness due to phosphor deterioration). To ensure the screen performance, we suggest using the visual display area of PDP module and performing the following

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methods.

- A. If the customer is required to use the fixed pattern, reduce the maximum brightness as low as possible, change the position of the displayed area or display the screen saver or moving picture periodically.
 - B. If possible, change the displayed color to equalize the total displayed time for each cell.
- (10) In system design and evaluation process, you should consider the maximum brightness level (image retention and image sticking).
 - (11) The PDP screen is displayed by image data signals and synchronized signals. If noise interferes with the signals, the PDP screen could be unstable. Thus, when you design, you should take measures to minimize the affects of noise
 - (12) For preventing from occurring condensation that consists of small drops of water which form when warm water vapor in the air touches a cold surface such as a panel glass moved from cold condition, the module need to be left in the room temperature for minimum 8 hours in box condition before use.
 - (13) The customer has to consider their packing box to prevent from occurring condensation during delivery to the End User from their packing material design stage.
 - (14) SAMSUNG SDI PDP module is a product for the computer, office automation, other office supplies, industry and communication, measurement devices, personal and home appliances. However, if you need to use the PDP module in particular situations, such as defective or abnormal operations can directly affect human life, injuries and damages in property could be caused, and high level of reliability is required (aerospace equipments, nuclear control systems, vehicle controls, life-supporting medical devices, etc.), you should consult with SAMSUNG SDI beforehand. SAMSUNG SDI will not take any responsibility for the problems and defects occurred in the course of usage without prior approval of SAMSUNG SDI
 - (15) Based on the requirements of the safety standard (UL, EN etc.), be sure to add the filter that come up to the impact test to the glass plate

□ ***Notice to the operation and handling of the Module***

- (1) To prevent defect or failure, please check the cable connections and power-supply condition before power-on.
- (2) The Module is controlled by high voltage. Not only during operation but also immediately after power-off, do not disconnect or reconnect the Module's connector because it may result in failure. If you need to disconnect or reconnect, you have to wait at least one minute after power-off.
- (3) The Module is equipped with various protection circuits that automatically stop the Module operation, if an interface signal or the power voltage becomes abnormal during

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operation. If the Module stops suddenly during operation, please check the conditions of input signal or power source before restarting.

- (4) For the protection of the circuit, if an abnormal situation is occurred, the high output voltage will be shut down by (watching) the internal input voltage (V_s / V_a / V_{cc}). In this case, the Module power resetting is necessary to recover. There are also fuses in the V_s and V_a power supply system to prevent smoking and firing by the excessive current. The protecting function of the address driver of keeping a supervisory device for the internal current is provided in the V_a power supply system. Therefore, the number of sub-frames decreases to a proper value when the I_a current exceeds a constant value occasionally.
- (5) If an abnormal situation such as disconnecting of the input connector occurs, this Module will be on stand-by, which the supply of high output voltage is stopped even if an external power is being supplied. If a normal signal is inputted after this, normal operation state, operations can be restarted again by re-inputting a normal signal. However, it is necessary to rest the Module power when t_{VH} and/or t_{HV} are less than the minimum value provided in the specification
- (6) To ensure reliable operation of the Module and to protect it from overheating, do not wrap or cover it with a cloth or like a sheet during power-on period. Also, do not place the Module in a confined space or any other places of poor ventilation.
- (7) If you continue to watch the naked screen (without filter glass) for a long time, your eyes could be fatigued. We recommend you rest your eyes occasionally. However, according to the information currently available, watching PDP module for a long time does not cause a direct harm to your eyes.
- (8) The screen is controlled with the display-data signals and synchronized signals. If noise interferes with those signals, the screen could become unstable and, in some case, would cause a failure. Do not place any equipment that generates excessive EMI/RFI noise near the interface cable of the Module, and keep the cables as short as possible.
- (9) Be careful not to break the glass panel when you handle the Module. Also, when handling the Module, you must wear gloves or other hand protection to prevent injuries that can occur in case when the glass panel is broken.
- (10) The glass panel section and drive circuit section of the Module are closely connected and they function as a pair. If the Module is arbitrarily recombined, restructured, or disassembled, SDI will not be responsible for the function, quality, or operational integrity of the modified Module. Do not recombine, restructure, or disassemble it. (Only, the Module for A/S is allowed to be recombined, restructured, or disassembled.)
- (11) To avoid a possible electric shock, you must make sure that the power supply voltage of Module is turned off before cleaning. To clean the module's glass panel, apply water or a natural detergent to a piece of soft cloth or gauze, and wring the cloth tightly before wiping the screen. Make sure that no water comes in contact with the connecting terminals on the side of the glass panel. Do not use chemical solvents, such as paint thinner or benzene, to clean the glass panel.

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- (12) The drive circuit section of Module uses C-MOS integrated circuits that must be protected from static electricity. Therefore, when transporting or delivering the Module, be sure to put the Module in an antistatic bag. When handling the Module, take adequate grounding precautions to prevent static electricity.
- (13) When delivering or transporting the Module, you must take special precautions because excessive vibration or shock should not be applied to it. If the Module is dropped, or (if) excessive vibration/shock is applied, the glass panel of the Module may be broken and the drive circuit may be damaged. The packing for delivering or transporting should be made with strict instructions.
- (14) The information and schematics shown in this specification are just examples of display applications; it does not mean that they must be applied to your device for the actual use. SAMSUNG SDI does not take any responsibility for the infringement of patent or any other intellectual rights arising from the use of the information or schematics in the document.
- (15) If any part or technology of the product described in this specification become subject to restrictions on export or any related laws or regulations, a prior permission is required before exporting.
- (16) The PDP module uses semiconductor devices. Since semiconductors are very sensitive to static electricity, the following requirements should be conformed during delivering, transferring and handling the PDP module: Remove the static electricity on your body by wearing the earth-ring which must be connected to the ground through high resistor (about 1M Ohm). It is recommended to wear the conductive clothes and shoes, use conductive floor mats, and take other measures to minimize the static electricity. All the equipments and tools must be connected to the ground and protected from static electricity. When you deliver or transfer the PDP module, always use anti-static bag.
- (17) If any device that can generate the high-voltage is located nearby the PDP module, it could cause an abnormal operation. In such a case, you should take a countermeasure to prevent against static electricity and discharges.
- (18) If the PDP module is exposed to corrosive gases or contacted to oil, it could cause chemical reactions and give unfavorable effects on the devices. If you intend to use the PDP module under such conditions, you must consider the ways to avoid exposure or to protect the PDP module before using it.
- (19) The PDP module is not designed to endure radiation or cosmic radiation. Users must install the proper shielding.
- (20) The PDP module uses thermo-plastic devices. Since these devices are easy to be damaged, do not use the PDP module nearby inflammable substances. If they are burnt, poisonous gas will be emitted.
- (21) To ensure the normal operation of the PDP module, the recommended operating range

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should be required. The electrical properties of the PDP module are guaranteed only when it is used within the recommended operating range. The PDP module must be used within the range at all time. If you use it out of the range, it could give adverse effects on its reliability or cause defects.

- (22) Flexible cables connect electrodes on the panel glass and PCBs. Thus, do not apply too much stress such as shock, vibration, pressure, or bending, to the surface of panel glass, PCBs and flexible cables.
- (23) If there is no special notice, the contents of this specification describe the product with the initial parameters after shipment.
- (24) Even if the panel glass is cleaned before shipping, there is a possibility of particle remained on the panel. In this case, remove it prior to the usage. When you clean the surface of the panel glass, use a piece of soft cloth with detergent to wipe off. Do not use any chemical substances such as acid, alkali or organic detergent.
- (25) The Module is composed of various kinds of materials such as glass, metals and plastics. A qualified service technician is required for the disposal of the Module

□ ***Notice to the storage of the Module***

- (1) When storing the Module, you must select an environmentally controlled place. Avoid any environment in which the temperature or humidity exceeds the specification values. If you are storing it for a long period of time, we recommend that you place the Module together with a dehumidifying agent, such as silica gel, in a moisture-proof bag and keep it in an environmentally controlled place.
- (2) If the module is stored for a long time, the discharge might not take place smoothly. In this case, aging approximately for minimum 2 hours with a full white pattern is suggested. Do aging once in every 6 months.
- (3) Do not place the PDP module in the environment with a rapid temperature change in order to avoid the condensation inside of the module.
- (4) Do not open the packages at dusty place or the place where corrosive gases exist.
- (5) Only qualified person can transfer the PDP module with a forklift or crane.

□ ***Notice to the repairing and fixing of the Module***

The PDP module is a product made with various tests and adjustments hence, repairing and fixing of PDP module is not allowed to conduct at customer's place. The issue must be handled separately from the specifications.

**SAMSUNG SDI Corporation****Plasma Display Panel****□ Notice of the Module performance**

The Module is the newest display device utilizing the gas discharge technology and digital signal processing technology, and its performances are mostly similar to those of CRT. However, some display performances of the PDP module are different from the CRT's. Please consider the following notices when you watch the screen.

- (1) There is (a) slight Neon luminance shown outside of the effective display area on the glass panel. Conceal these parts so that it may not be seen on the display surface.
- (2) Depending on the type and time of usage, there may be a slight change in the Luminance and color. There may be an increase of both X-value and Y-value by 0.05 at the maximum in chromaticity. In this case, adjust it using the external data signal.
- (3) Because the Module uses phosphor to emit a light, the phosphor, like a CRT, will be deteriorated in proportion to the display signal and Luminance settings. If the same pattern is displayed continuously (fixed display) for an extended period of time, the Luminance of that area will be decreased over non-lit areas due to the fact that the discharge surface will be more activated comparing to the other areas.
- (4) When the Vsync signal timing becomes shorter right after the changing of Vsync frequency (e.g. from 50 Hz to 60 Hz) depending on the Multi-Vsync function, an initial Vsync signal of the changed frequency will be disregarded and the screen will be interrupted for 1 frame period in maximum.
- (5) Because the Module is a digital processing display device, this Module is equipped with the Error diffusion technology and a Duplicated Sub-Frame method to display the grayscale and false contour improvement. However, you may sometimes find a color false contour, especially in human facial contour, in moving picture due to the difference of display performance comparing to the TV-tube.
- (6) If the Module displays some video test patterns that are mostly used in a laboratory or inspection process of the manufacturing facilities, you may find the following subjects. But these subjects should not be recognized in the failure or defects because the display performance of the Module is equipped with Error diffusion technology and Duplicated Sub-Frame method (for PAL) based on digital processing technique.

<a> Linearity in the grayscale test pattern

If the PDP module displays the grayscale test pattern (e.g. white color Luminance is gradually changed horizontally or vertically) in a screen, you may find the disparity of Luminance at adjacent grayscale patterns. This behavior is caused by duplicated sub-frame condition (for PAL), display load correction and electroad dependency.

 Color contouring and dithering at the stationary picture

If the stationary picture such as a human face or the like is shown in the screen, you may feel some unstable noise at the contour area. This behavior is called the color contouring or dithering, and is caused by the error diffusion condition, display load correction and electroad dependency.

**SAMSUNG SDI Corporation****Plasma Display Panel**

- (7) If the Module is operated under inadequate conditions or harsh environment, the screen may become unstable or noisy. This instability is mostly related to ambient temperature, air pressure, input signal instability (include signal noise), input power voltage and strong magnetic field such as MRI/NMR application or superconducting magnet application. Please do not apply the Module to inadequate conditions or harsh environment mentioned above.

□ ***PDP DESIGN GUIDELINES AGAINST CORROSIVE GASES/HIGH HUMIDITY***

During the PDP development stage , some materials which may generate corrosive gas(es) or ions such as sulfur, sodium, and chlorine, etc must not be allowed to use in the modules. If the material mentioned above is used or located close to the address terminals, chemical reaction may occur and cause the modules to fail.

If customer wishes to use some materials due to unavoidable cause, then safe gap between address terminals and the material(s) which may generate corrosive gas(es) is minimum 5mm or customer must keep or deliver PDP always in room temperature and room humidity state at any cases.

It is a mandatory guide line to protect the modules from corrosive gases or ions.

If some material contains sulfur (sulfur) ,Natrium (sodium) and Chloride , then Samsung SDI strongly suggests customer to keep the guidelines.

The weight of material containing sulfur must be no more than 300ppm .

The analysis of the sulfur weight is based on the noramlized " ICP-AES" method.